

NICHIA CORPORATION

SPECIFICATIONS FOR WHITE LED

NF2W757GT-V3F1

- Pb-free Reflow Soldering Application
- Built-in ESD Protection Device
- RoHS Compliant



SPECIFICATIONS

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	I_F	180	mA
Pulse Forward Current	I_{FP}	240	mA
Allowable Reverse Current	I_R	85	mA
Power Dissipation	P_D	540	mW
Operating Temperature	T_{opr}	-40~100	°C
Storage Temperature	T_{stg}	-40~100	°C
Junction Temperature	T_J	120	°C

* Absolute Maximum Ratings at $T_J=25^{\circ}\text{C}$.

* I_{FP} conditions with pulse width $\leq 10\text{ms}$ and duty cycle $\leq 10\%$.

* For I_F and I_{FP} , see the "DERATING CHARACTERISTICS" of this specification.

(2) Initial Electrical/Optical Characteristics

Item		Symbol	Condition	Typ	Max	Unit
Forward Voltage		V_F	$I_F=65\text{mA}$	2.73	-	V
R70	Luminous Flux (Chromaticity Coordinate1)	Φ_v	$I_F=65\text{mA}$	37.5	-	lm
R8000			$I_F=65\text{mA}$	35.3	-	
R9050			$I_F=65\text{mA}$	29.4	-	
Chromaticity Coordinate1	x	-	$I_F=65\text{mA}$	0.4338	-	-
	y		$I_F=65\text{mA}$	0.4030	-	
R70	Luminous Flux (Chromaticity Coordinate2)	Φ_v	$I_F=65\text{mA}$	38.8	-	lm
R8000			$I_F=65\text{mA}$	37.3	-	
R9050			$I_F=65\text{mA}$	32.3	-	
Chromaticity Coordinate2	x	-	$I_F=65\text{mA}$	0.3447	-	-
	y		$I_F=65\text{mA}$	0.3553	-	
Thermal Resistance		$R_{\theta JS}$	-	11	17	°C/W

* Characteristics at $T_J=25^{\circ}\text{C}$ and measured in pulse mode.

* Optical Characteristics as per CIE 127:2007 standard.

* Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

* $R_{\theta JS}$ is measured using the Dynamic Mode detailed in JESD51-1.

* $R_{\theta JS}$ is the thermal resistance from the junction to the T_S measurement point. (Test board: FR4 board thickness=1.6mm, copper layer thickness=0.07mm)

RANKS

Item	Rank		Condition	Min	Max	Unit
Forward Voltage	-		I _F =65mA	2.5	3.0	V
Luminous Flux	P13		I _F =65mA	42.8	51.0	lm
	P12			36.0	42.8	
	P11			30.3	36.0	
	P10			25.5	30.3	
	P9			21.4	25.5	
Color Rendering Index	R70	R _a	I _F =65mA	70	-	-
	R8000	R _a		80	-	
		R ₉		0	-	
	R9050	R _a		90	-	
		R ₉		50	-	

Color Ranks($I_F=65\text{mA}$)

The color ranks have chromaticity ranges within 3-step MacAdam ellipse.

		Rank sm203	Rank sm223	Rank sm253	Rank sm273	Rank sm303	Rank sm353
Color Temperature (Unit: K)	T_{CP}	2000	2200	2500	2700	3000	3500
Center Point	x	0.5270	0.5018	0.4806	0.4578	0.4338	0.4073
	y	0.4130	0.4153	0.4141	0.4101	0.4030	0.3917
Minor Axis	a	0.003978	0.004002	0.004029	0.004056	0.004107	0.004098
Major Axis	b	0.007062	0.007206	0.007515	0.007872	0.008391	0.008796
Ellipse Rotation Angle	Φ	-43.56	-39.89	-37.58	-36.05	-36.00	-35.47

		Rank sm403	Rank sm453	Rank sm503	Rank sm573	Rank sm653
Color Temperature (Unit: K)	T_{CP}	4000	4500	5000	5700	6500
Center Point	x	0.3818	0.3611	0.3447	0.3287	0.3123
	y	0.3797	0.3658	0.3553	0.3417	0.3282
Minor Axis	a	0.004071	0.003852	0.003555	0.003087	0.002709
Major Axis	b	0.009282	0.009009	0.008418	0.007809	0.006561
Ellipse Rotation Angle	Φ	-35.95	-34.33	-31.78	-31.56	-32.35

The color ranks have chromaticity ranges within 5-step MacAdam ellipse.

		Rank sm2050a	Rank sm2050b	Rank sm2050c	Rank sm2050d	Rank sm2050e	Rank sm2050f
Color Temperature (Unit: K)	T_{CP}	2000					
Center Point	x	0.5270					
	y	0.4130					
Minor Axis	a	0.006630					
Major Axis	b	0.011770					
Ellipse Rotation Angle	Φ	-43.56					

		Rank sm2250a	Rank sm2250b	Rank sm2250c	Rank sm2250d	Rank sm2250e	Rank sm2250f
Color Temperature (Unit: K)	T_{CP}	2200					
Center Point	x	0.5018					
	y	0.4153					
Minor Axis	a	0.006670					
Major Axis	b	0.012010					
Ellipse Rotation Angle	Φ	-39.89					

		Rank sm2550a	Rank sm2550b	Rank sm2550c	Rank sm2550d	Rank sm2550e	Rank sm2550f
Color Temperature (Unit: K)	T_{CP}	2500					
Center Point	x	0.4806					
	y	0.4141					
Minor Axis	a	0.006715					
Major Axis	b	0.012525					
Ellipse Rotation Angle	Φ	-37.58					

		Rank sm2750a	Rank sm2750b	Rank sm2750c	Rank sm2750d	Rank sm2750e	Rank sm2750f
Color Temperature (Unit: K)	T_{CP}	2700					
Center Point	x	0.4578					
	y	0.4101					
Minor Axis	a	0.006760					
Major Axis	b	0.013120					
Ellipse Rotation Angle	Φ	-36.05					

		Rank sm3050a	Rank sm3050b	Rank sm3050c	Rank sm3050d	Rank sm3050e	Rank sm3050f
Color Temperature (Unit: K)	T_{CP}	3000					
Center Point	x	0.4338					
	y	0.4030					
Minor Axis	a	0.006845					
Major Axis	b	0.013985					
Ellipse Rotation Angle	Φ	-36.00					

		Rank sm3550a	Rank sm3550b	Rank sm3550c	Rank sm3550d	Rank sm3550e	Rank sm3550f
Color Temperature (Unit: K)	T_{CP}	3500					
Center Point	x	0.4073					
	y	0.3917					
Minor Axis	a	0.006830					
Major Axis	b	0.014660					
Ellipse Rotation Angle	Φ	-35.47					

		Rank sm4050a	Rank sm4050b	Rank sm4050c	Rank sm4050d	Rank sm4050e	Rank sm4050f
Color Temperature (Unit: K)	T_{CP}	4000					
Center Point	x	0.3818					
	y	0.3797					
Minor Axis	a	0.006785					
Major Axis	b	0.015470					
Ellipse Rotation Angle	Φ	-35.95					

		Rank sm4550a	Rank sm4550b	Rank sm4550c	Rank sm4550d	Rank sm4550e	Rank sm4550f
Color Temperature (Unit: K)	T_{CP}	4500					
Center Point	x	0.3611					
	y	0.3658					
Minor Axis	a	0.006420					
Major Axis	b	0.015015					
Ellipse Rotation Angle	Φ	-34.33					

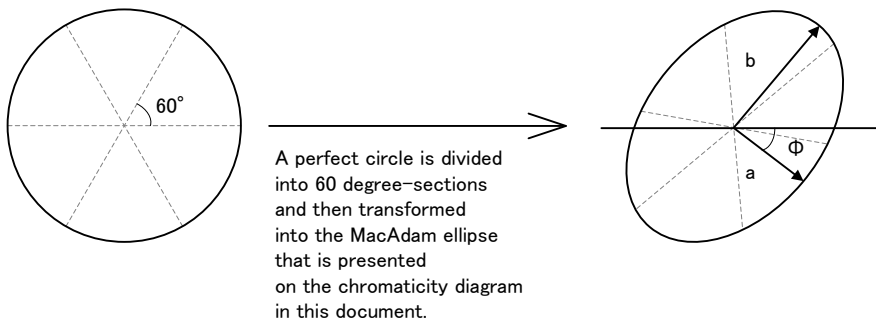
		Rank sm5050a	Rank sm5050b	Rank sm5050c	Rank sm5050d	Rank sm5050e	Rank sm5050f
Color Temperature (Unit: K)	T_{CP}	5000					
Center Point	x	0.3447					
	y	0.3553					
Minor Axis	a	0.005925					
Major Axis	b	0.014030					
Ellipse Rotation Angle	Φ	-31.78					

		Rank sm5750a	Rank sm5750b	Rank sm5750c	Rank sm5750d	Rank sm5750e	Rank sm5750f
Color Temperature (Unit: K)	T_{CP}	5700					
Center Point	x	0.3287					
	y	0.3417					
Minor Axis	a	0.005145					
Major Axis	b	0.013015					
Ellipse Rotation Angle	Φ	-31.56					

		Rank sm6550a	Rank sm6550b	Rank sm6550c	Rank sm6550d	Rank sm6550e	Rank sm6550f
Color Temperature (Unit: K)	T_{CP}	6500					
Center Point	x	0.3123					
	y	0.3282					
Minor Axis	a	0.004515					
Major Axis	b	0.010935					
Ellipse Rotation Angle	Φ	-32.35					

- * Ranking at $T_J=25^{\circ}\text{C}$ and measured in pulse mode.
- * Forward Voltage Tolerance: $\pm 0.05\text{V}$
- * Luminous Flux Tolerance: $\pm 5\%$
- * Color Rendering Index R_a Tolerance: ± 1.5
- * Color Rendering Index R_9 Tolerance: ± 3
- * The R_9 value for the above rank shall be greater than 0.
- * Chromaticity Coordinate Tolerance: ± 0.003
- * LEDs from the above ranks will be shipped. The rank combination ratio per shipment will be decided by Nichia.

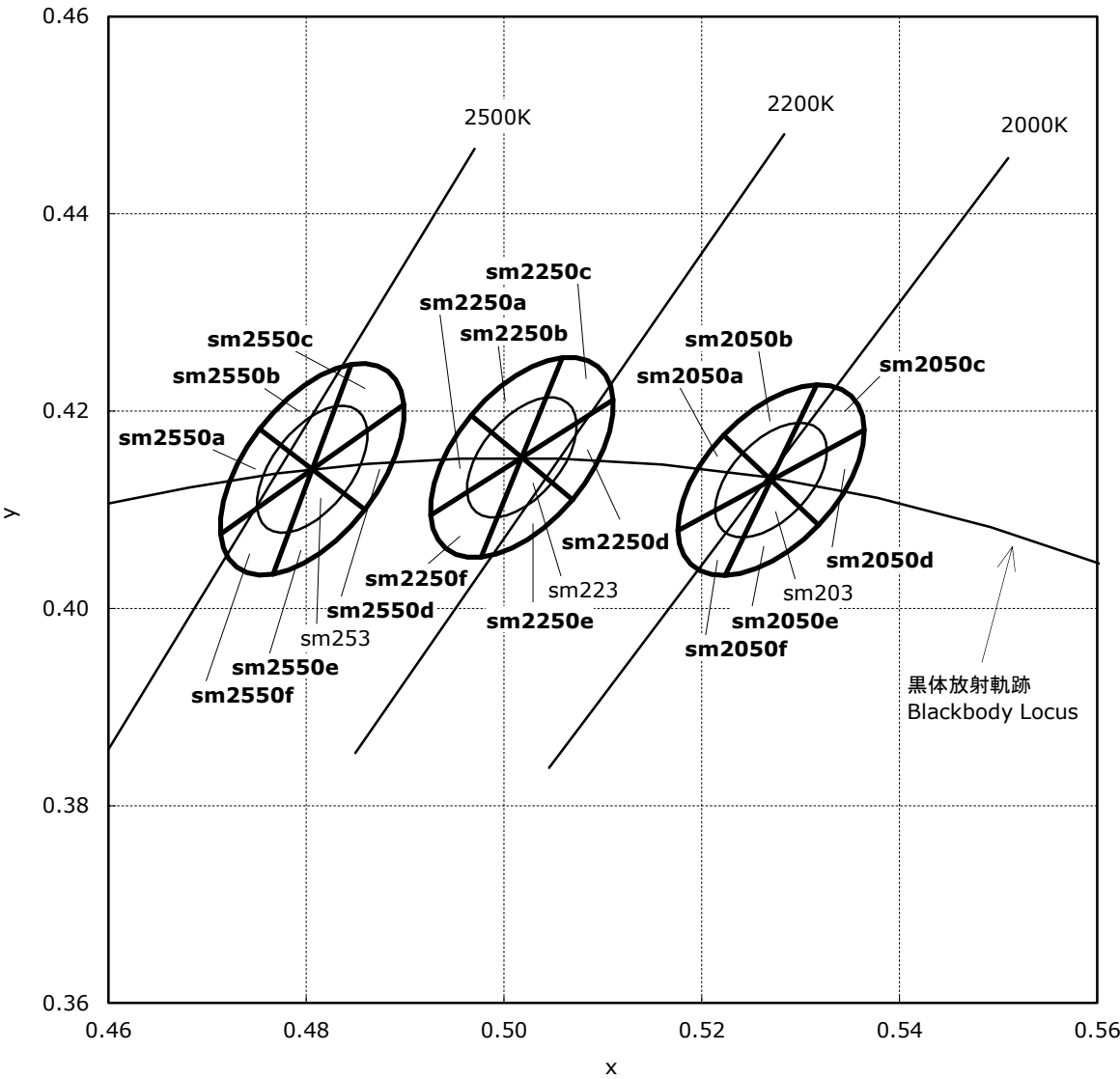
Definition of the MacAdam ellipse ranks:



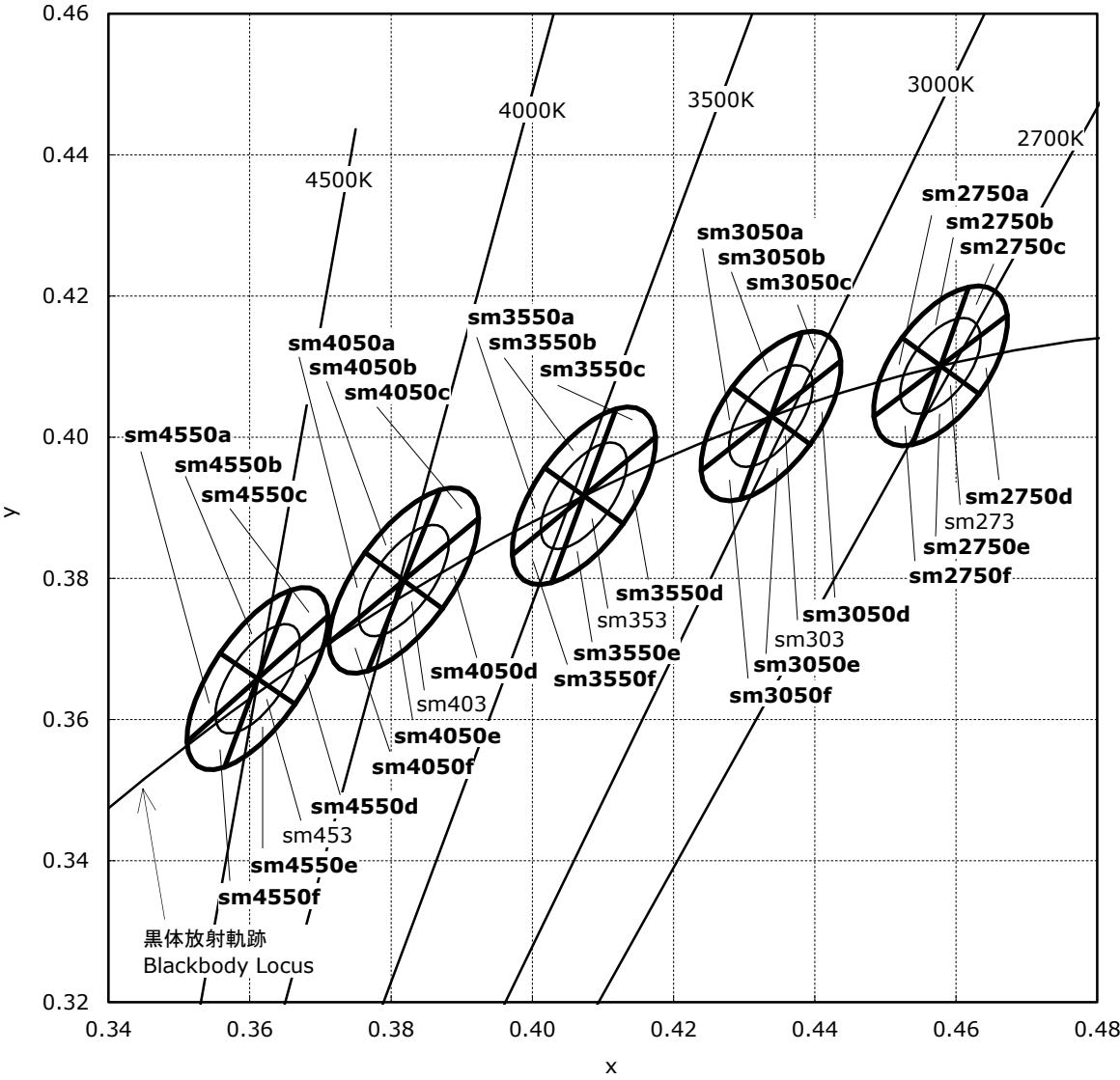
Luminous Flux Ranks by Color Rank, Color Rendering Index Rank

Ranking by Color Coordinates, Color Rendering Index		Ranking by Luminous Flux		P9	P10	P11	P12	P13
sm203,sm2050a,sm2050b,sm2050c,sm2050d,sm2050e,sm2050f, sm223,sm2250a,sm2250b,sm2250c,sm2250d,sm2250e,sm2250f		R8000						
sm253,sm2550a,sm2550b,sm2550c,sm2550d,sm2550e,sm2550f		R8000						
sm273,sm2750a,sm2750b,sm2750c,sm2750d,sm2750e,sm2750f		R70						
		R8000						
		R9050						
sm303,sm3050a,sm3050b,sm3050c,sm3050d,sm3050e,sm3050f		R70,R8000						
		R9050						
sm353,sm3550a,sm3550b,sm3550c,sm3550d,sm3550e,sm3550f, sm403,sm4050a,sm4050b,sm4050c,sm4050d,sm4050e,sm4050f, sm453,sm4550a,sm4550b,sm4550c,sm4550d,sm4550e,sm4550f, sm503,sm5050a,sm5050b,sm5050c,sm5050d,sm5050e,sm5050f, sm573,sm5750a,sm5750b,sm5750c,sm5750d,sm5750e,sm5750f, sm653,sm6550a,sm6550b,sm6550c,sm6550d,sm6550e,sm6550f		R70						
		R8000						
		R9050						

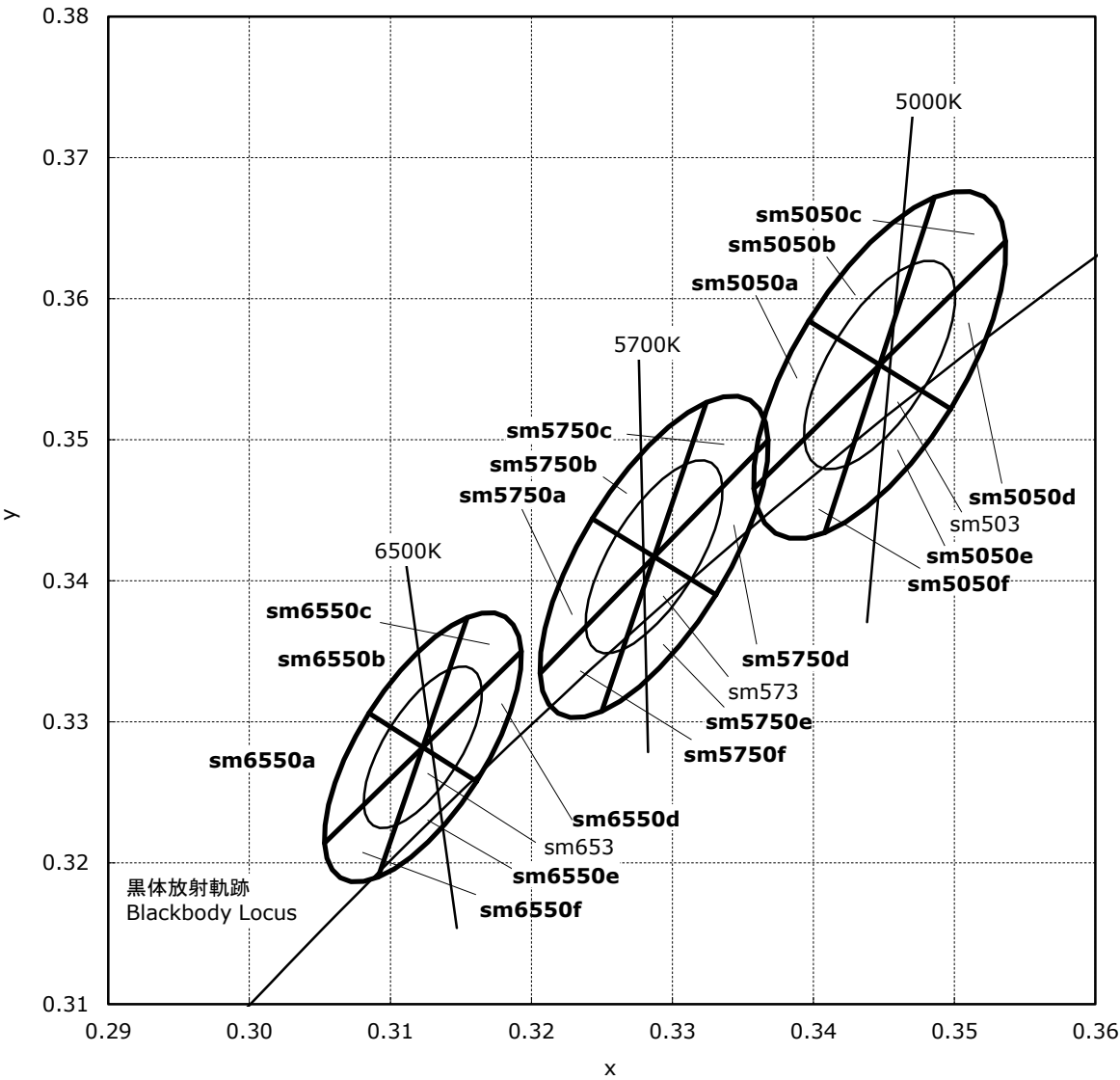
CHROMATICITY DIAGRAM



CHROMATICITY DIAGRAM



CHROMATICITY DIAGRAM



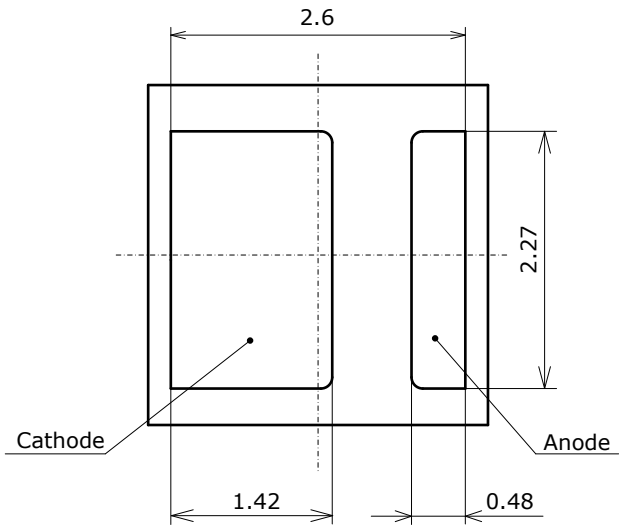
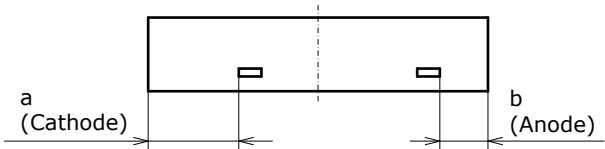
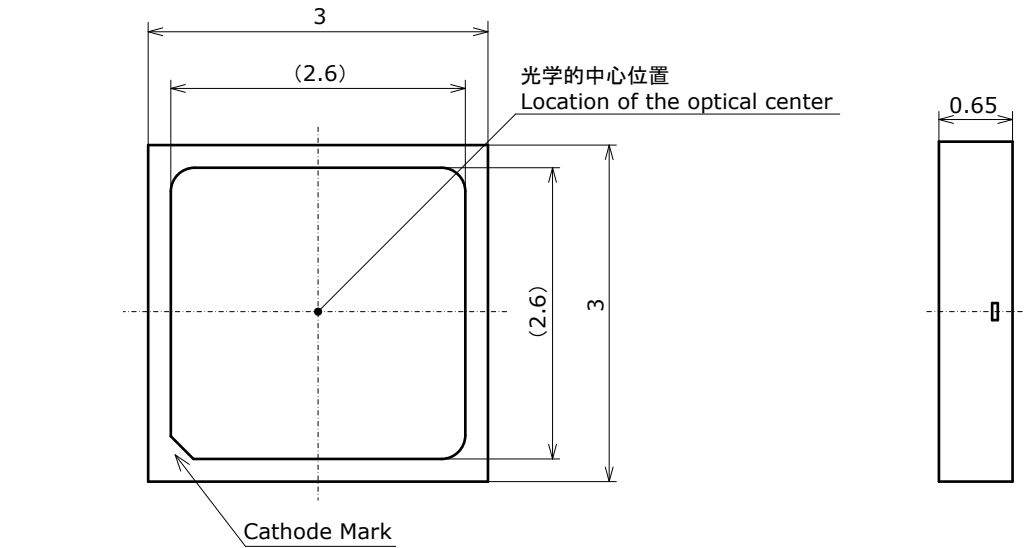
OUTLINE DIMENSIONS

* 本製品はRoHS指令に適合しております。
This product complies with RoHS Directive.

* 括弧で囲まれた寸法は参考値です。
The dimension(s) in parentheses are for reference purposes.

NF_xW757G-V_x
管理番号 No. STS-DA7-11807

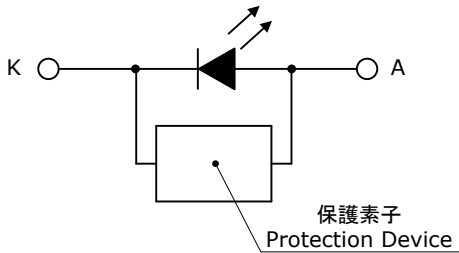
(単位 Unit: mm, 公差 Tolerance: ±0.2)



項目 Item	内容 Description
パッケージ材質 Package Materials	耐熱性ポリマー Heat-Resistant Polymer
封止樹脂材質 Encapsulating Resin Materials	シリコン樹脂 (拡散剤+蛍光体入り) Silicone Resin (with diffuser and phosphor)
電極材質 Electrodes Materials	銅合金+銀メッキ Ag-plated Copper Alloy
質量 Weight	0.018g(TYP)

* バリは寸法に含まないものとします。
Dimensions do not include mold flash.

* a>bとなる場合、aがカソード側です。
The side with the larger distance is the cathode.
Example: a>b, then a is the side that has the cathode.



- Recommended Hand Soldering Condition

1 to 5°C per sec

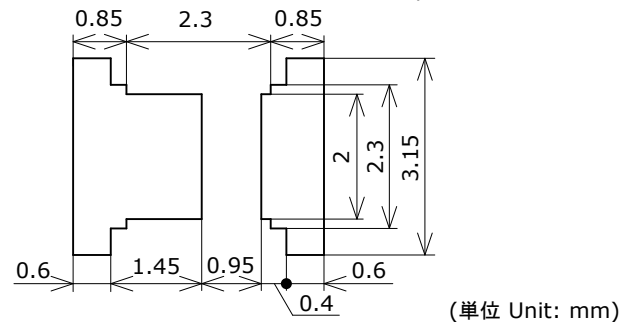
Pre-heat
180 to 200°C

120sec Max

60sec Max
Above 220°C

260°C Max
10sec Max

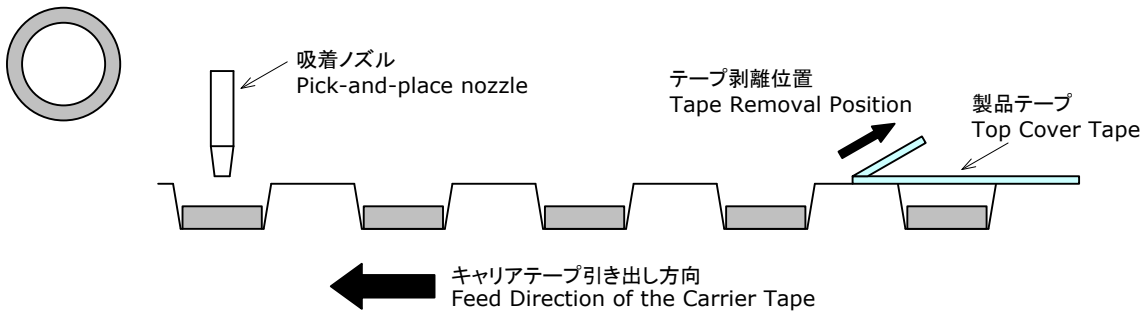
- Recommended Metal Solder Stencil Aperture



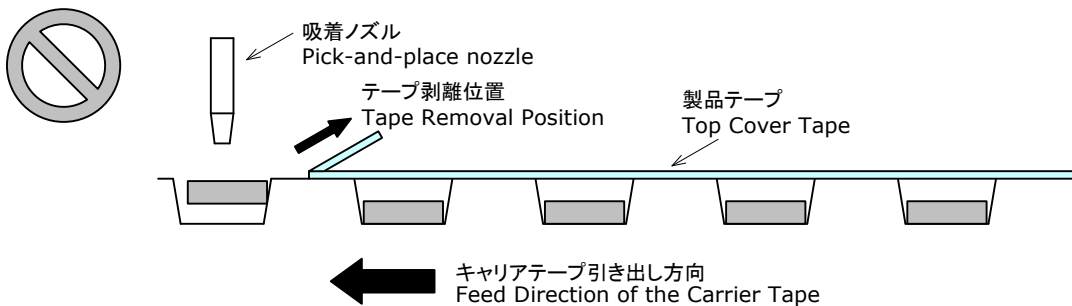
11

* If the top cover tape is removed right next to where the nozzle picks up the LEDs, regardless of whether the LEDs have been baked or not, it may cause the LED to be picked up incorrectly; it is recommended to remove the top cover tape further from where the nozzle picks up the LEDs. Ensure that there are no issues with the conditions when the nozzle picks up the LEDs.

- Recommended Tape Removal Position (Removing the cover tape further from the pick-and-place nozzle)



- Incorrect Tape Removal Position (Removing the cover tape right next to the pick-and-place nozzle)



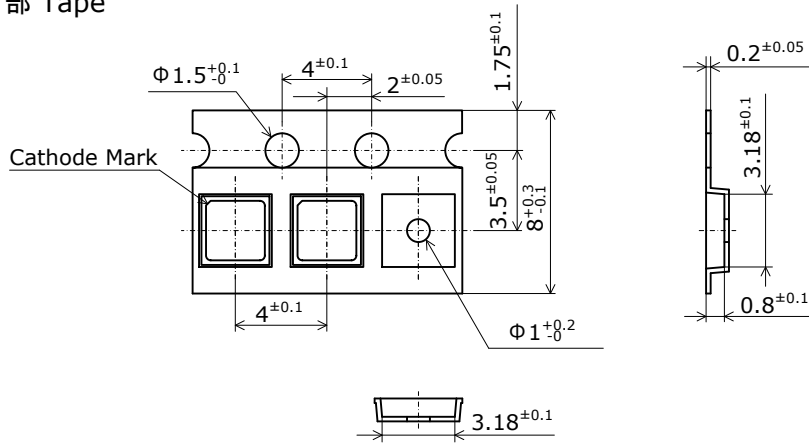
- * Verify the setting conditions when the LEDs are mounted onto a PCB to ensure that the LEDs are mounted onto the PCB with the correct polarity. If the cathode mark is not able to be easily recognized with a visual inspection, check the back or side of the LED to determine the polarity.
- * The soldering pad pattern above is a general recommendation for LEDs to be mounted without issues; if a high degree of precision is required for the chosen application (i.e. high-density mounting), ensure that the soldering pad pattern is optimized.
- * Consider factors such as the reflow soldering temperature, hand soldering temperature, etc. when choosing the solder.
- * When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
- * Ensure that there are no issues with the type and amount of solder that is being used.
- * This LED has all the electrodes on the backside; solder connections will not be able to be seen nor confirmed by a normal visual inspection. Ensure that sufficient verification is performed on the soldering conditions prior to use to ensure that there are no issues.

TAPE AND REEL DIMENSIONS

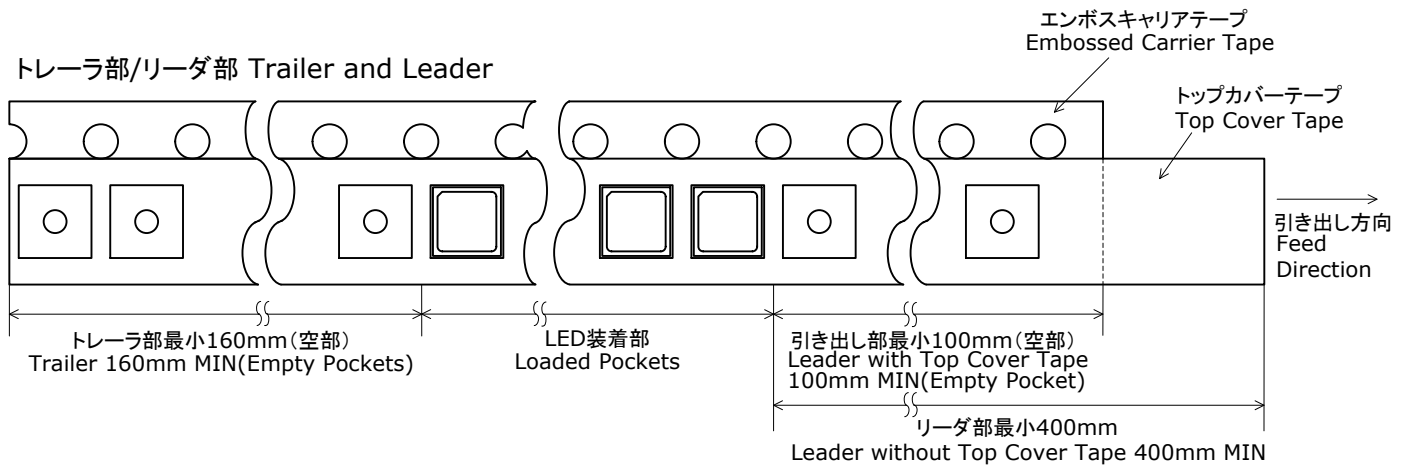
テーピング部 Tape

Nxxx757x
管理番号 No. STS-DA7-11808

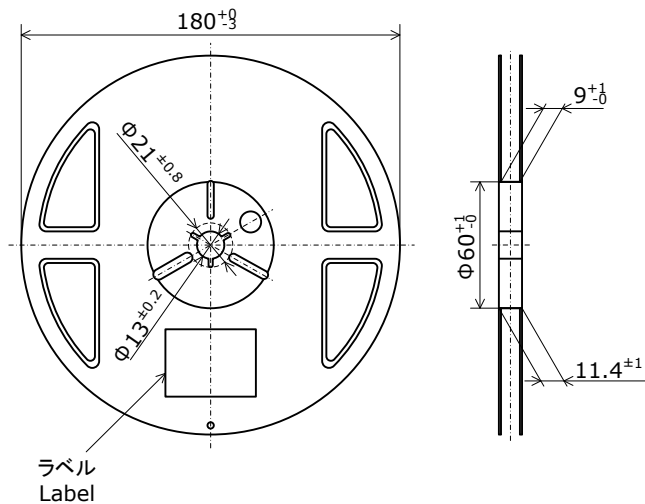
(単位 Unit: mm)



トレーラ部/リーダ部 Trailer and Leader



リール部 Reel



* 数量は1リールにつき 5000個入りです。

Reel Size: 5000pcs

* 実装作業の中断などでエンボスキャリアテープをリールに巻き取る場合、エンボスキャリアテープを強く(10N以上)締めないで下さい。LEDがカバーテープに貼り付く可能性があります。

When the tape is rewound due to work interruptions, no more than 10N should be applied to the embossed carrier tape. The LEDs may stick to the top cover tape.

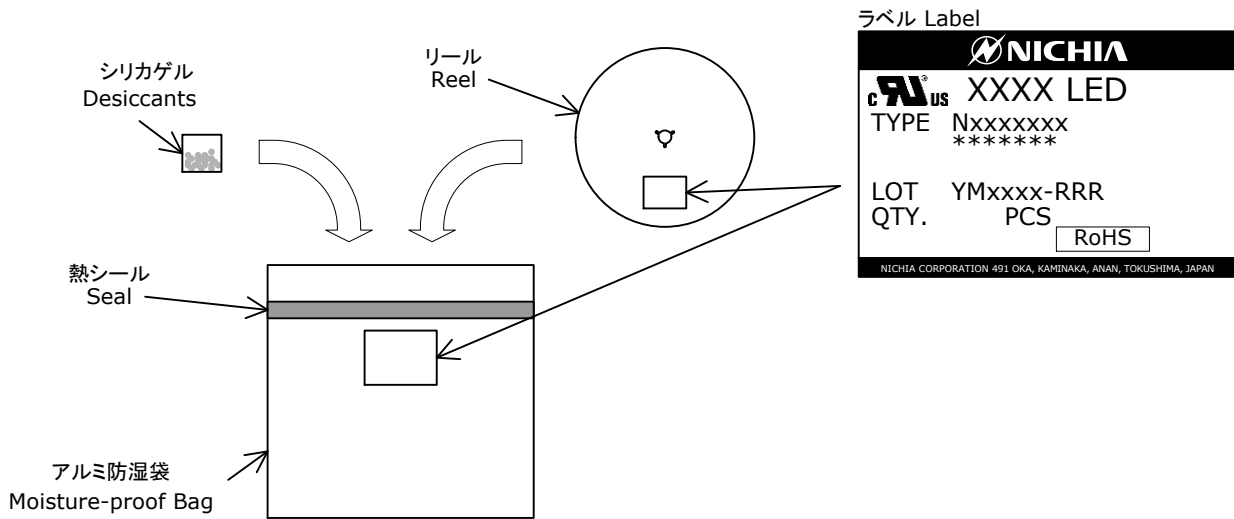
* JIS C 0806電子部品テーピングに準拠しています。

The tape packing method complies with JIS C 0806 (Packaging of Electronic Components on Continuous Tapes).

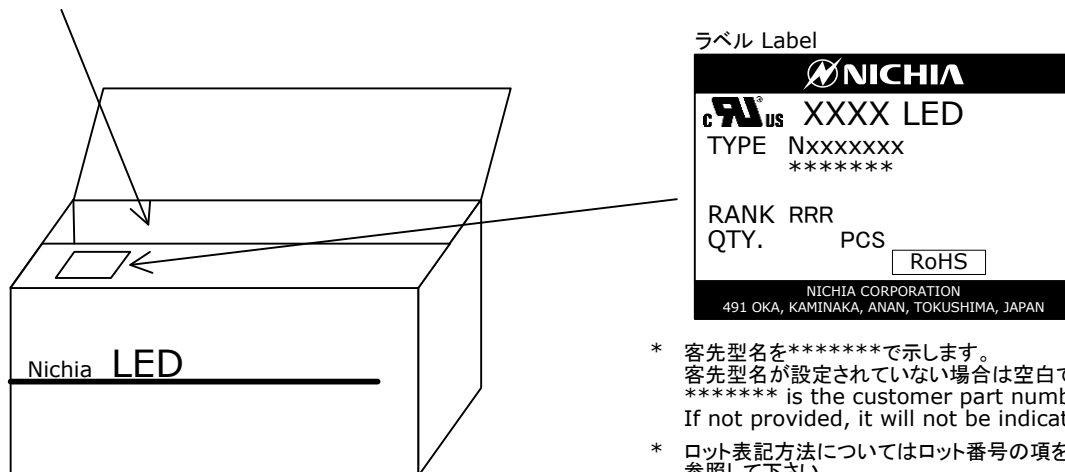
PACKAGING - TAPE & REEL

シリカゲルとともにリールをアルミ防湿袋に入れ、熱シールにより封をします。
Reels are shipped with desiccants in heat-sealed moisture-proof bags.

Nxxxxxxx
管理番号 No. STS-DA7-4989



アルミ防湿袋を並べて入れ、ダンボールで仕切ります。
Moisture-proof bags are packed in cardboard boxes with corrugated partitions.



- * 客先型名を*****で示します。
客先型名が設定されていない場合は空白です。
***** is the customer part number.
If not provided, it will not be indicated on the label.
- * ロット表記方法についてはロット番号の項を参照して下さい。
For details, see "LOT NUMBERING CODE" in this document.
- * ランク分けがない場合はランク表記はありません。
The label does not have the RANK field for un-ranked products.

- * 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
Products shipped on tape and reel are packed in a moisture-proof bag.
They are shipped in cardboard boxes to protect them from external forces during transportation.
- * 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。
Do not drop or expose the box to external forces as it may damage the products.
- * ダンボールには防水加工がされておきませんので、梱包箱が水に濡れないよう注意して下さい。
Do not expose to water. The box is not water-resistant.
- * 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。
Using the original package material or equivalent in transit is recommended.

LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Y
2017	H
2018	I
2019	J
2020	K
2021	L
2022	M

M - Month

Month	M	Month	M
1	1	7	7
2	2	8	8
3	3	9	9
4	4	10	A
5	5	11	B
6	6	12	C

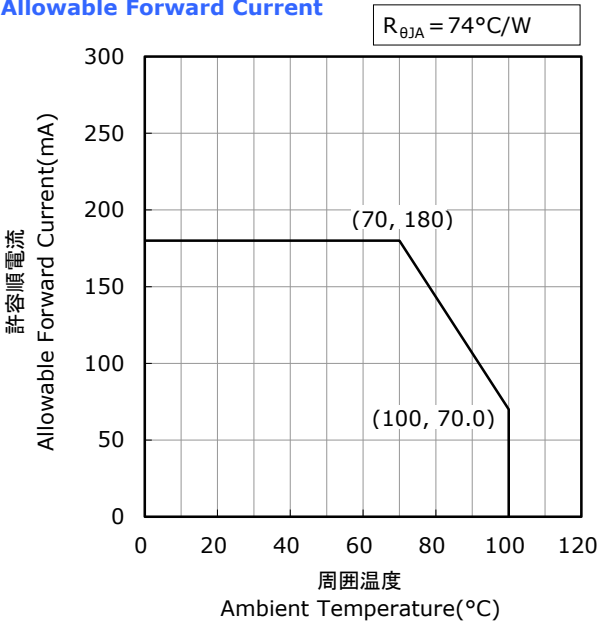
xxxx-Nichia's Product Number

RRR-Ranking by Color Coordinates, Ranking by Luminous Flux, Ranking by Color Rendering Index

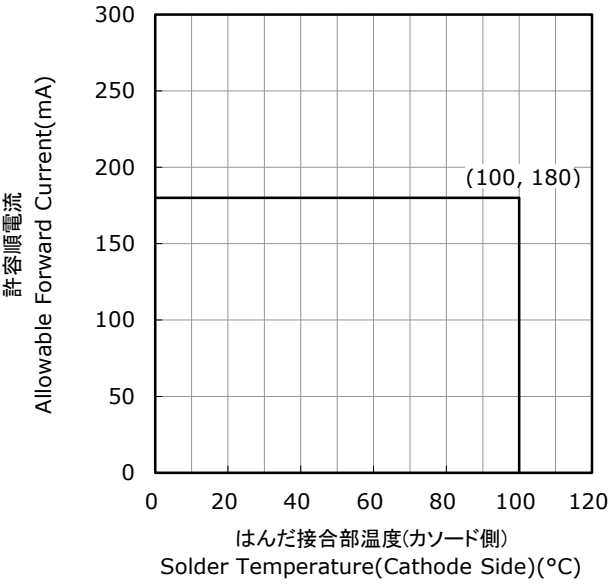
DERATING CHARACTERISTICS

Nx2x757G-Vx
管理番号 No. STS-DA7-10321A

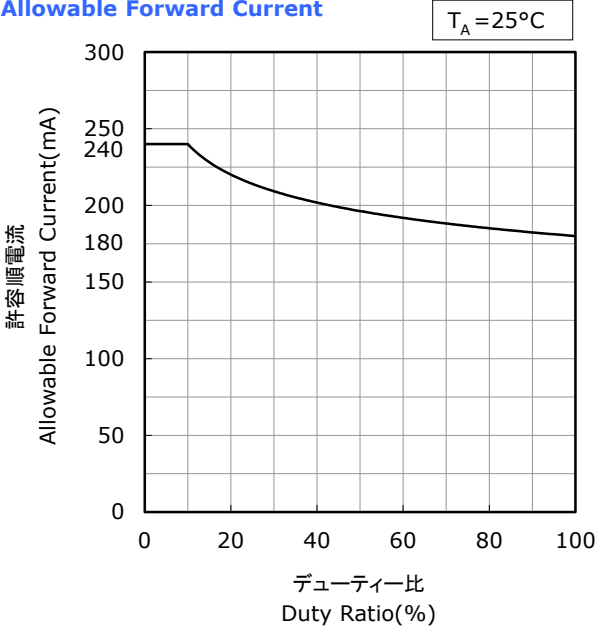
周囲温度-許容順電流特性
Ambient Temperature vs
Allowable Forward Current



はんだ接合部温度(カソード側)-許容順電流特性
Solder Temperature(Cathode Side) vs
Allowable Forward Current



デューティー比-許容順電流特性
Duty Ratio vs
Allowable Forward Current

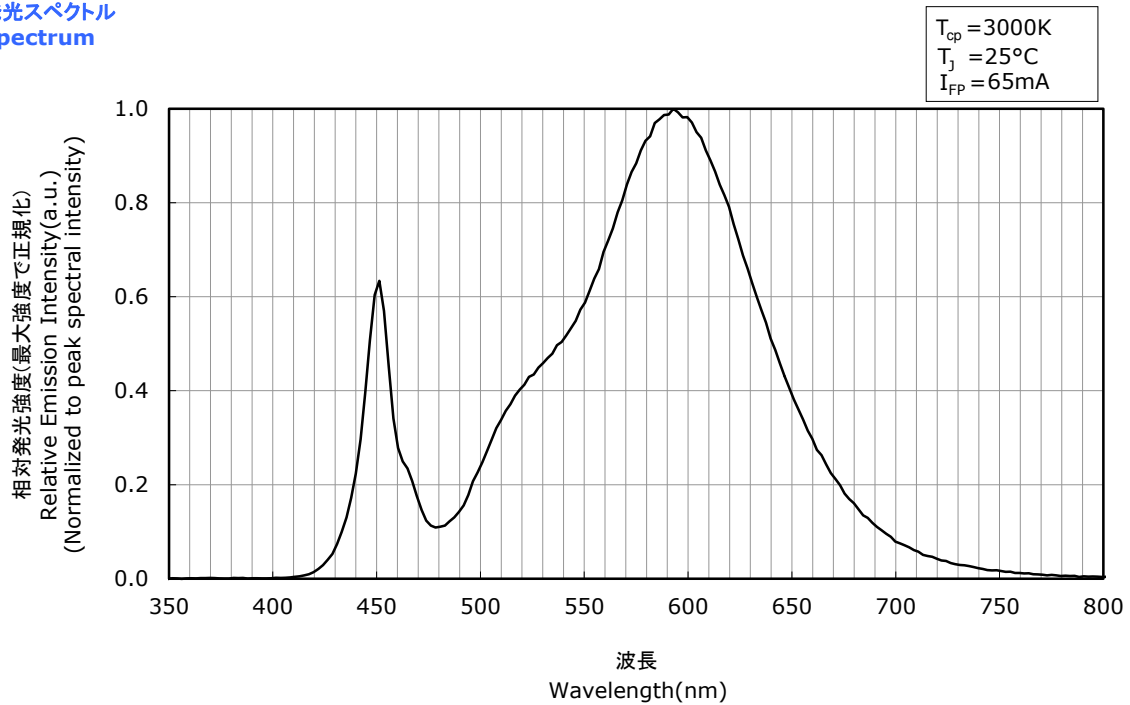


OPTICAL CHARACTERISTICS

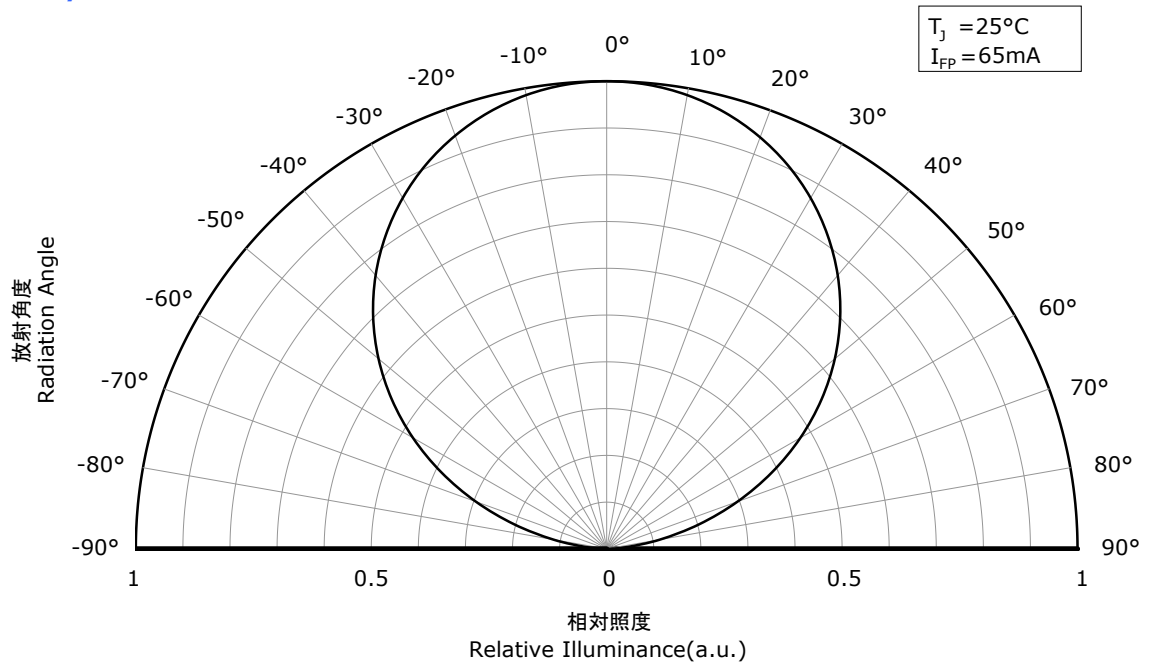
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13983

発光スペクトル
Spectrum



指向特性
Directivity



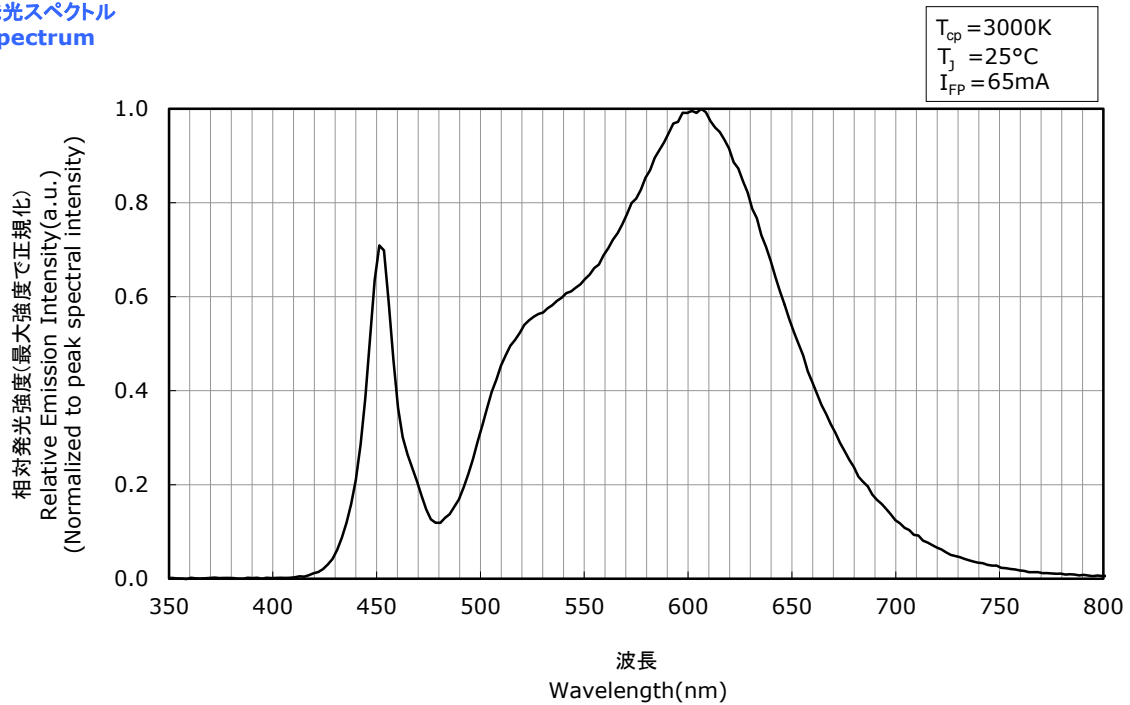
- * 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

OPTICAL CHARACTERISTICS

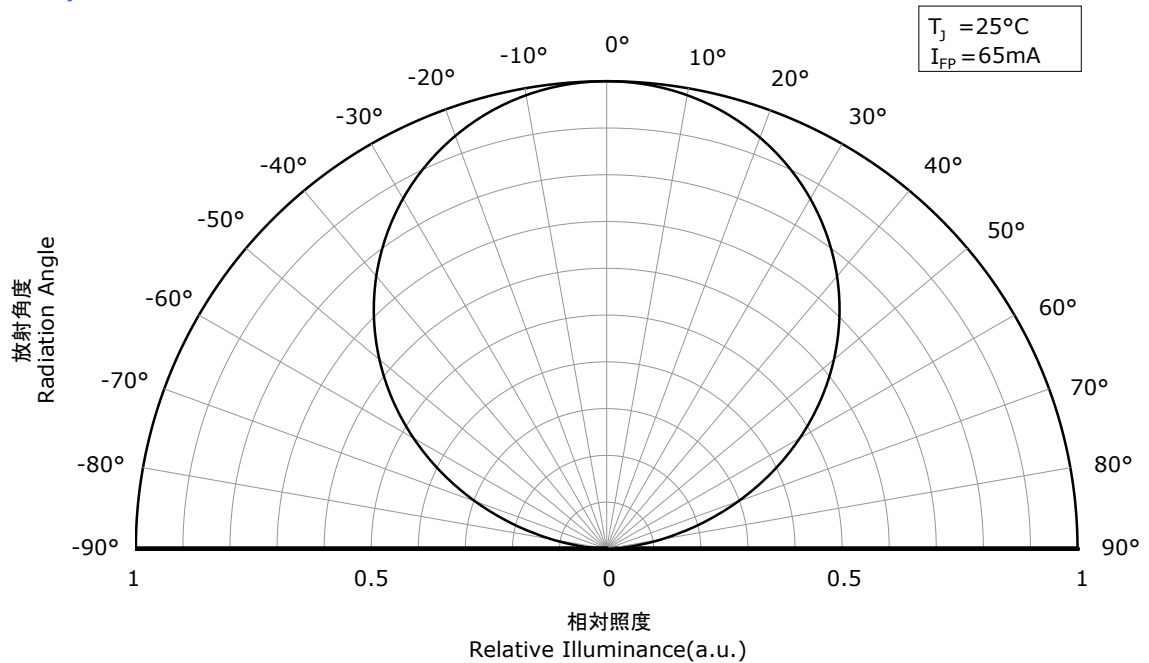
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13984

発光スペクトル
Spectrum



指向特性
Directivity



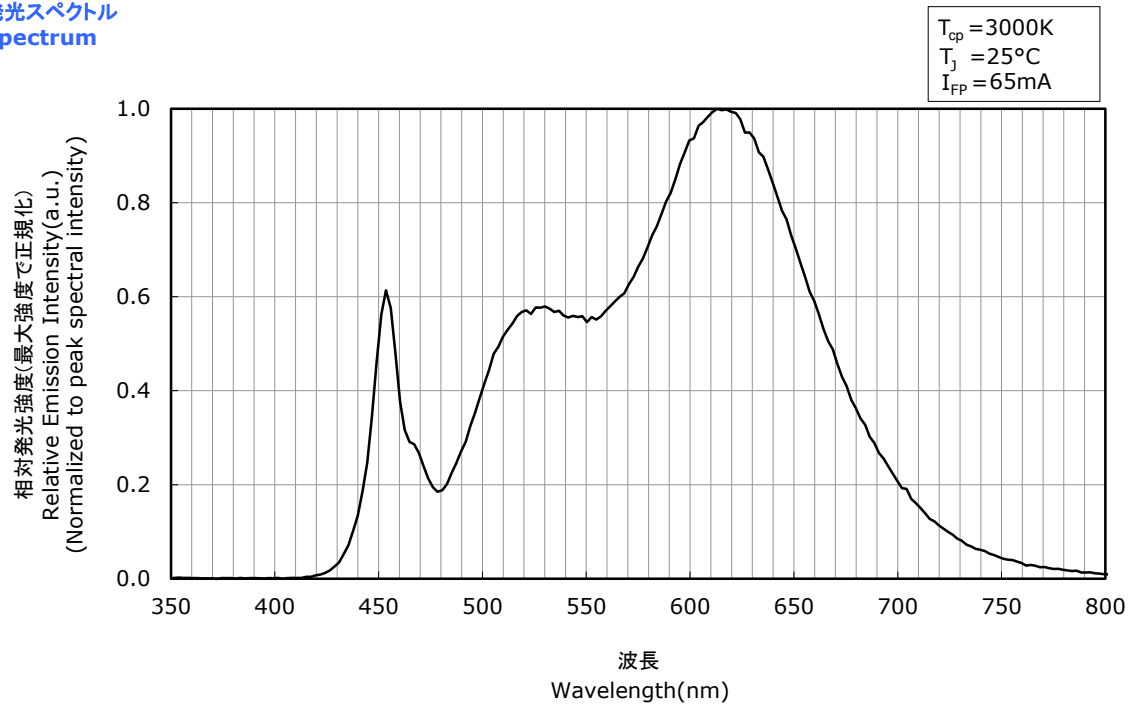
- * 本特性は演色性ランクR8000に対応しています。
The graphs above show the characteristics for R8000 LEDs of this product.

OPTICAL CHARACTERISTICS

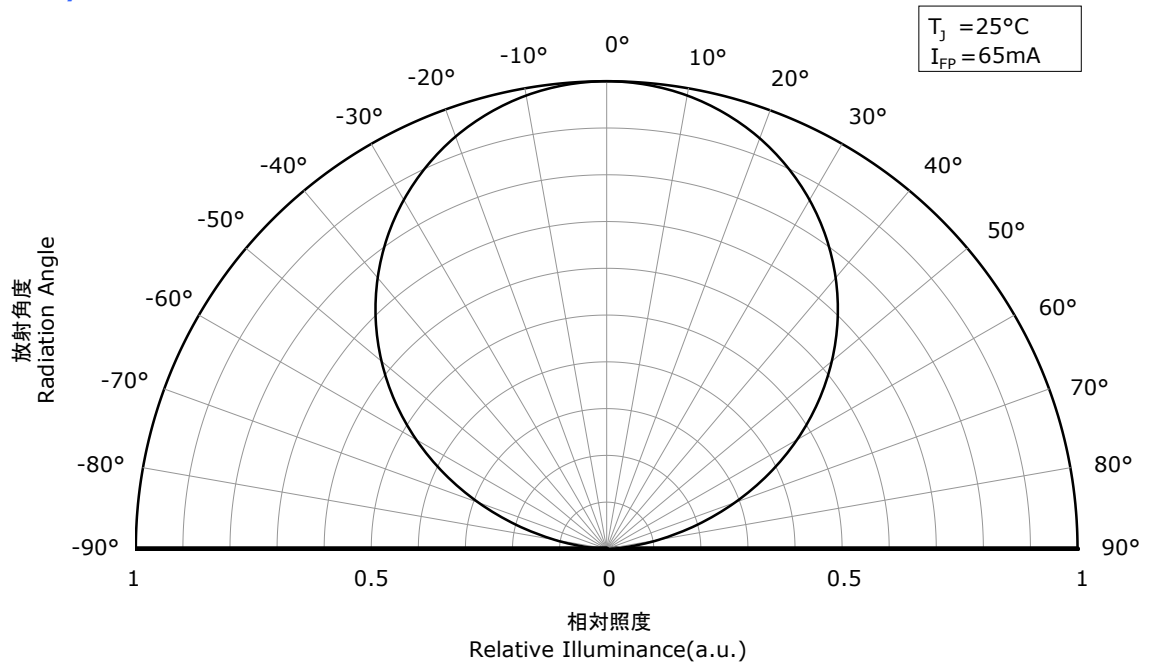
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13985

発光スペクトル
Spectrum



指向特性
Directivity



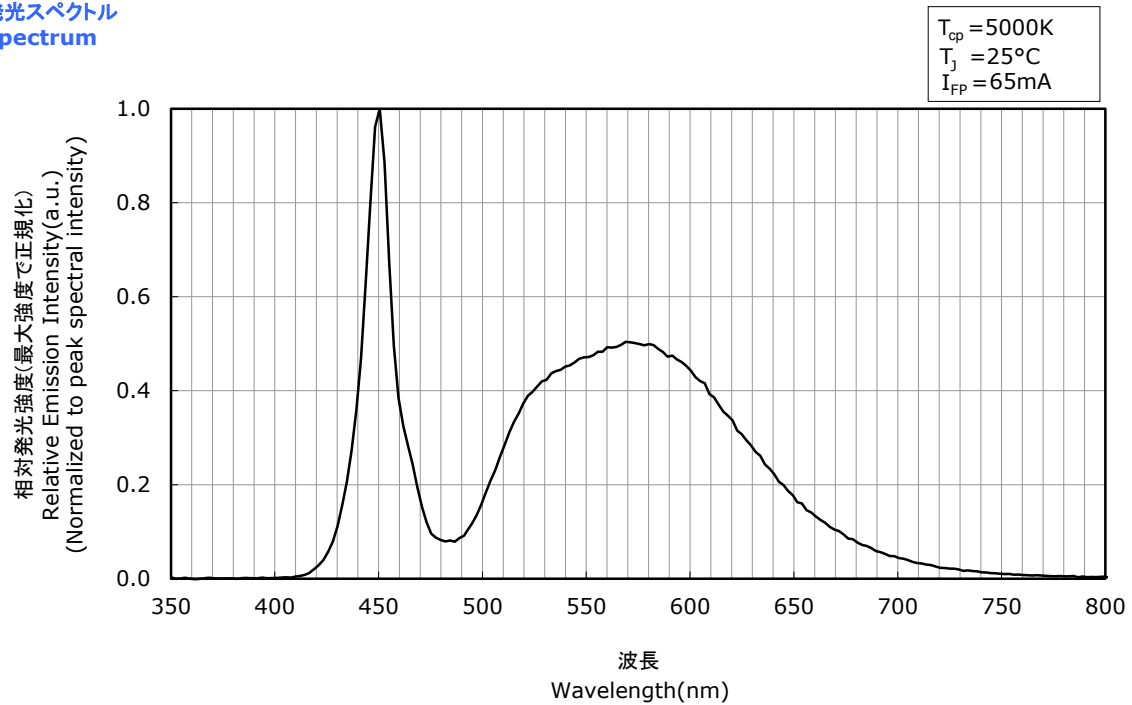
- * 本特性は演色性ランクR9050に対応しています。
The graphs above show the characteristics for R9050 LEDs of this product.

OPTICAL CHARACTERISTICS

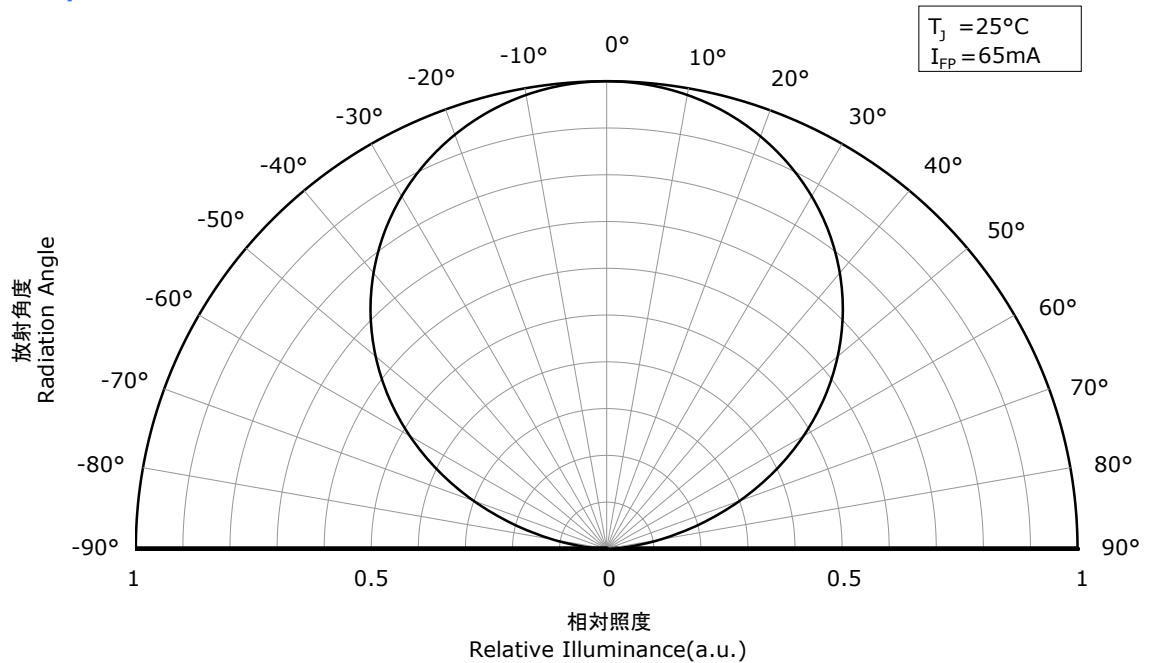
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13986

発光スペクトル
Spectrum



指向特性
Directivity



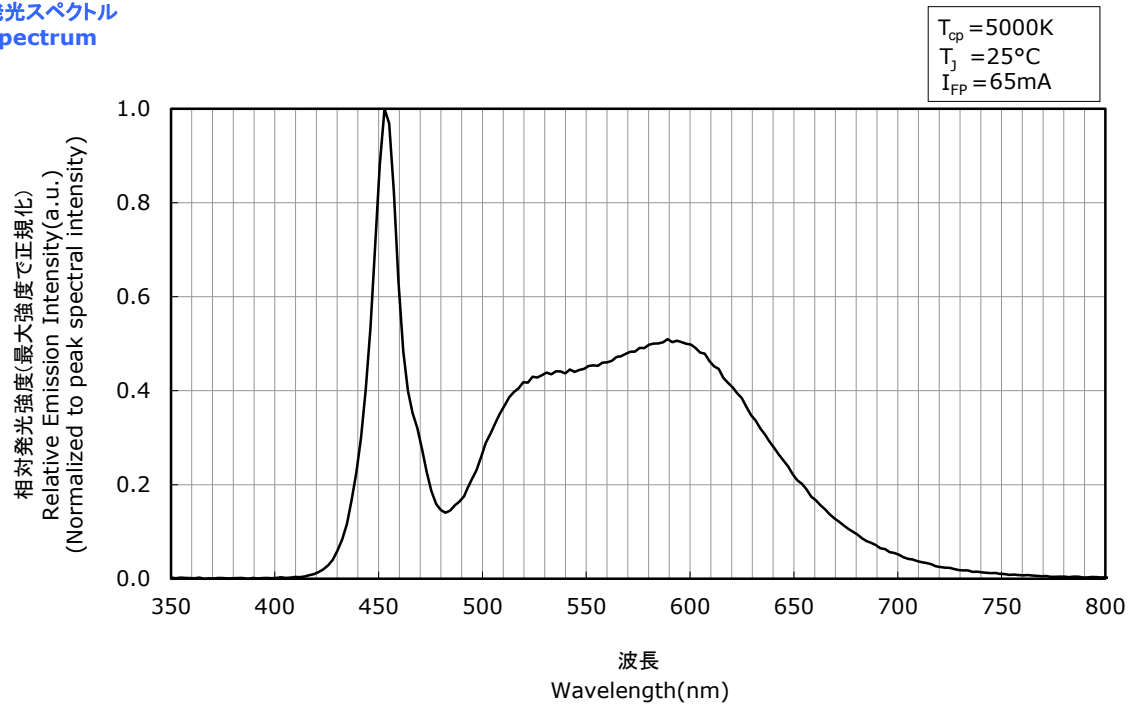
- * 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

OPTICAL CHARACTERISTICS

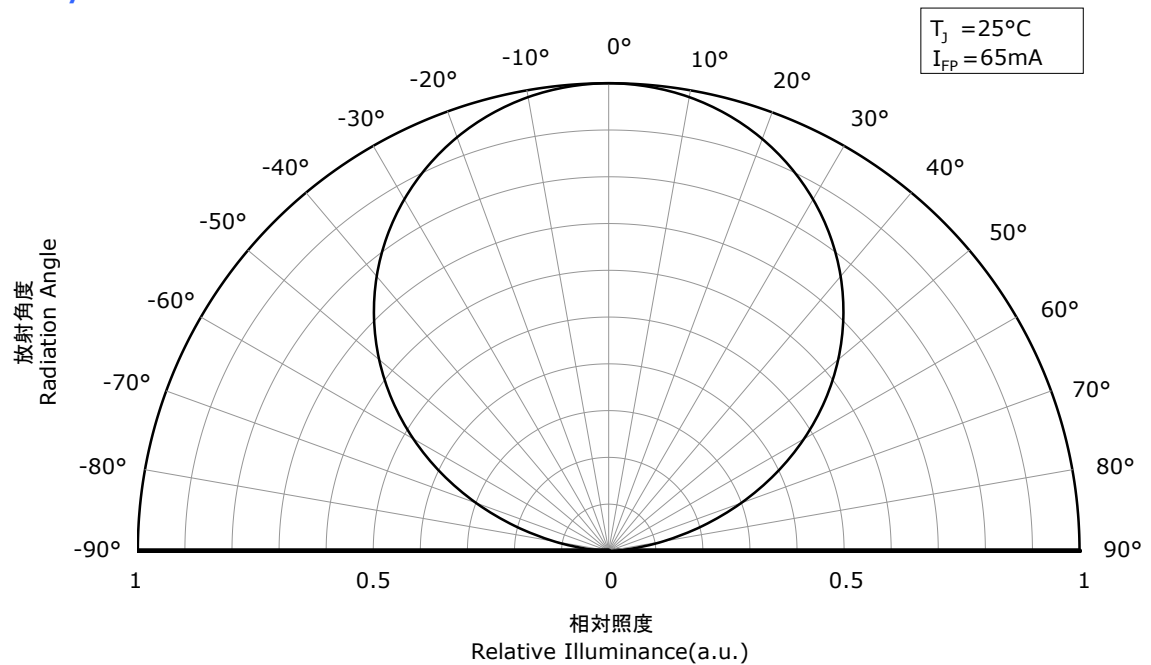
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13987

発光スペクトル
Spectrum



指向特性
Directivity



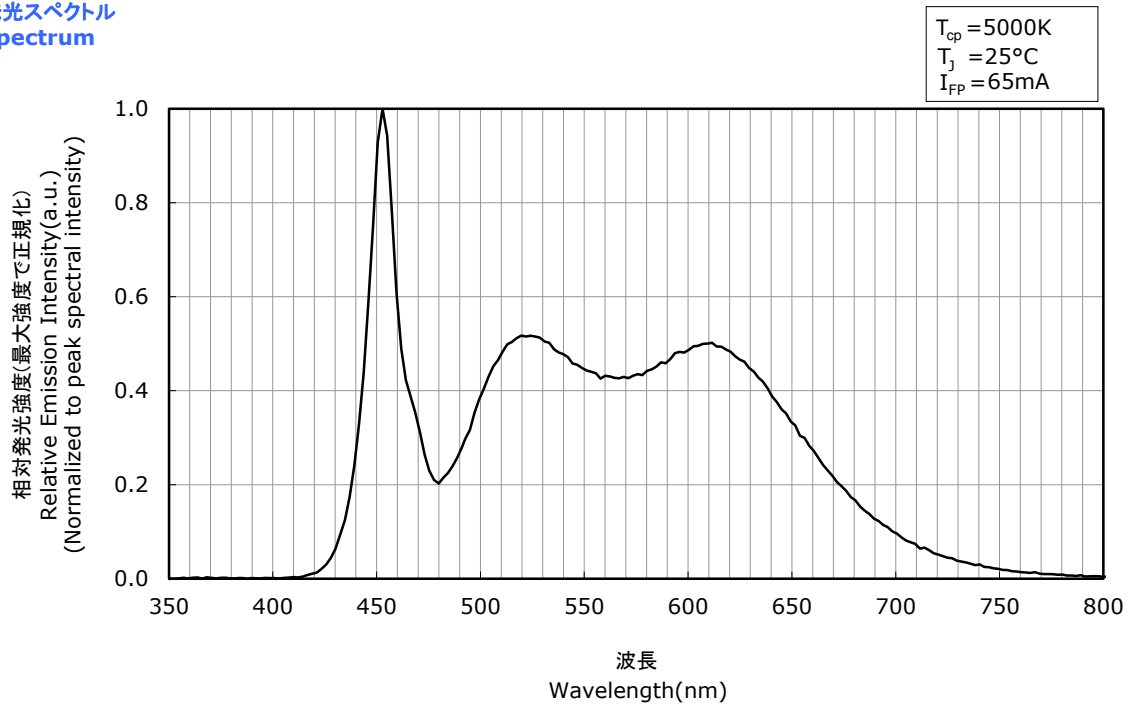
- * 本特性は演色性ランクR8000に対応しています。
The graphs above show the characteristics for R8000 LEDs of this product.

OPTICAL CHARACTERISTICS

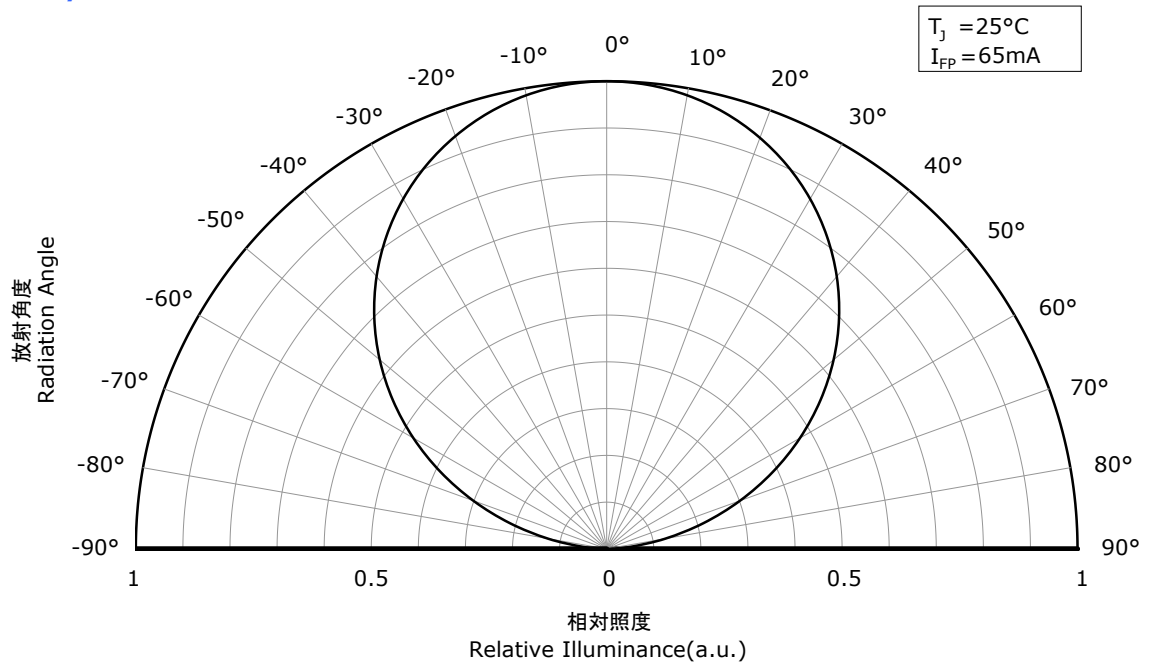
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13988

発光スペクトル
Spectrum



指向特性
Directivity



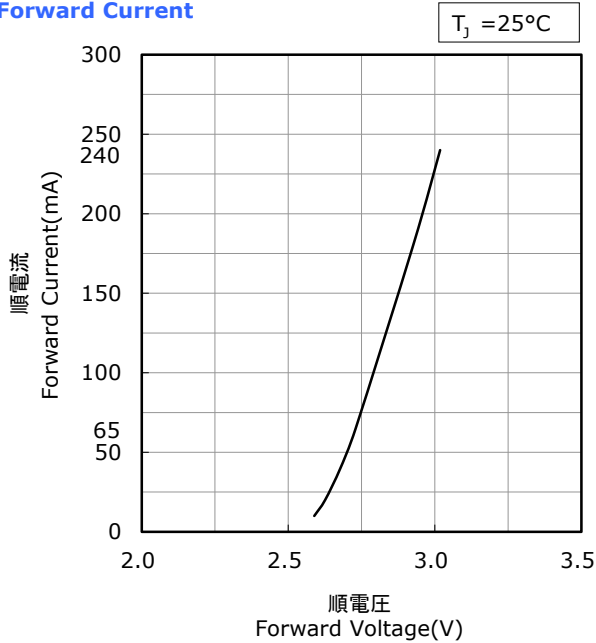
- * 本特性は演色性ランクR9050に対応しています。
The graphs above show the characteristics for R9050 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

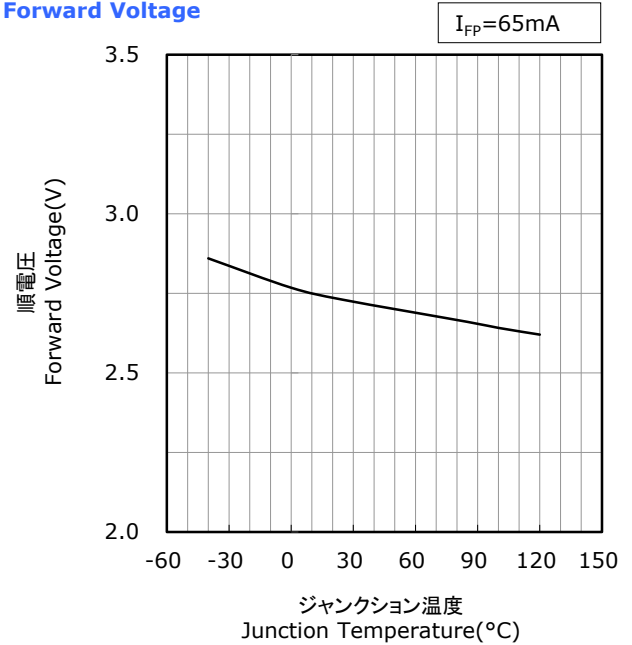
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13989

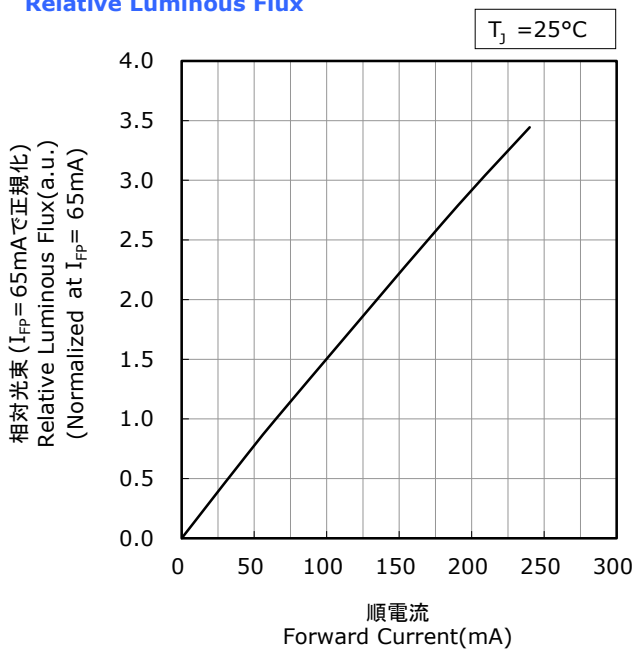
順電圧-順電流特性
Forward Voltage vs
Forward Current



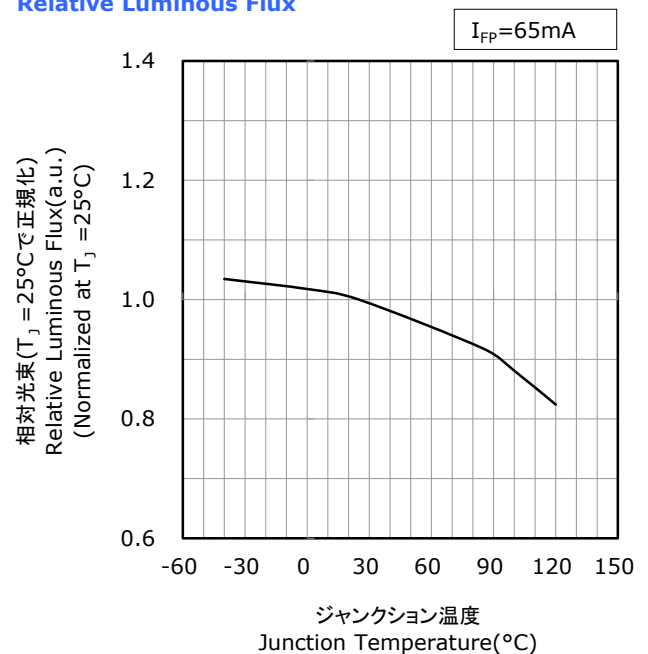
ジャンクション温度-順電圧特性
Junction Temperature vs
Forward Voltage



順電流-相対光束特性
Forward Current vs
Relative Luminous Flux



ジャンクション温度-相対光束特性
Junction Temperature vs
Relative Luminous Flux



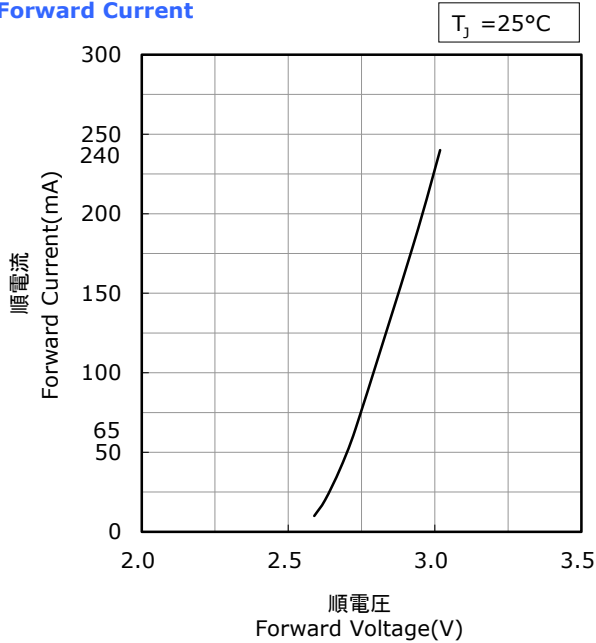
- * 本特性は色温度2700K~4500K、演色性ランクR70に対応しています。
The graphs above show the characteristics for 2700K~4500K, R70 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

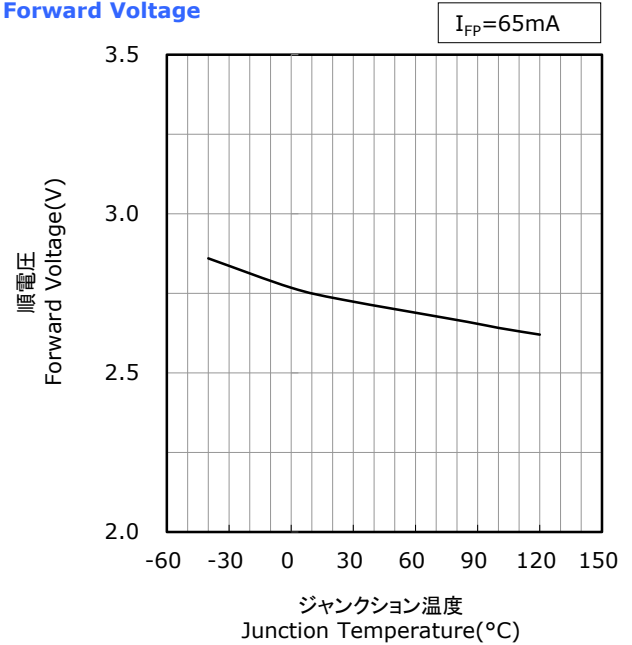
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13990

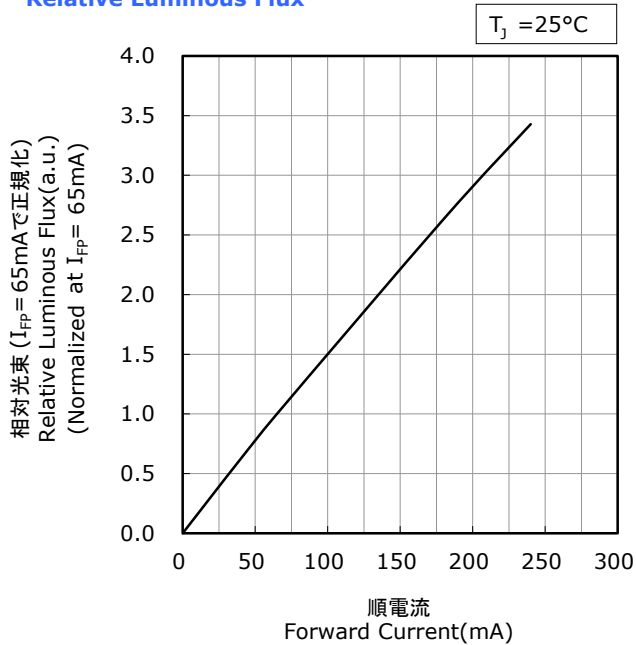
順電圧-順電流特性
Forward Voltage vs
Forward Current



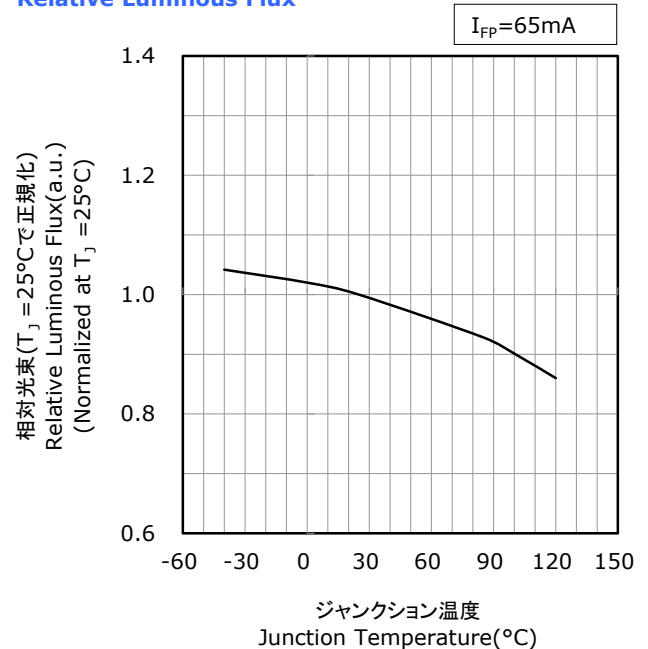
ジャンクション温度-順電圧特性
Junction Temperature vs
Forward Voltage



順電流-相対光束特性
Forward Current vs
Relative Luminous Flux



ジャンクション温度-相対光束特性
Junction Temperature vs
Relative Luminous Flux



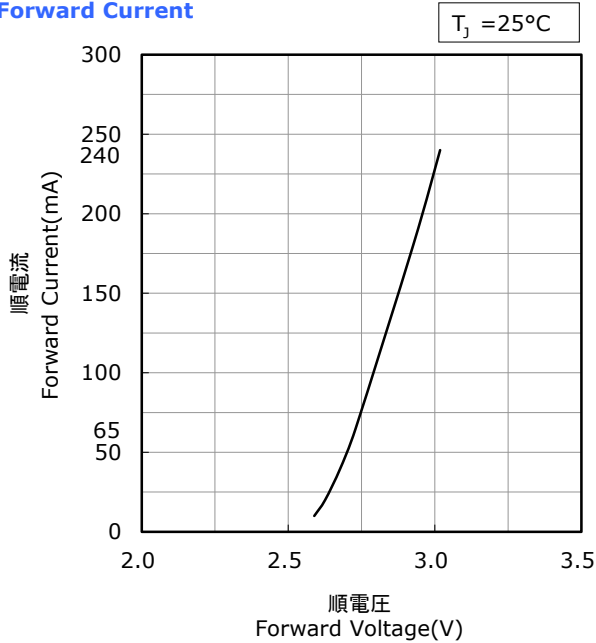
- * 本特性は色温度2000K~4500K、演色性ランクR8000に対応しています。
The graphs above show the characteristics for 2000K~4500K, R8000 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

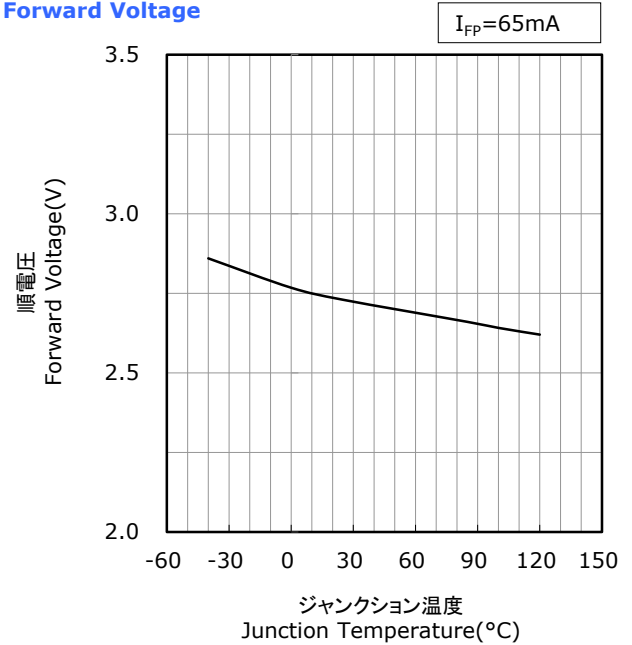
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13991

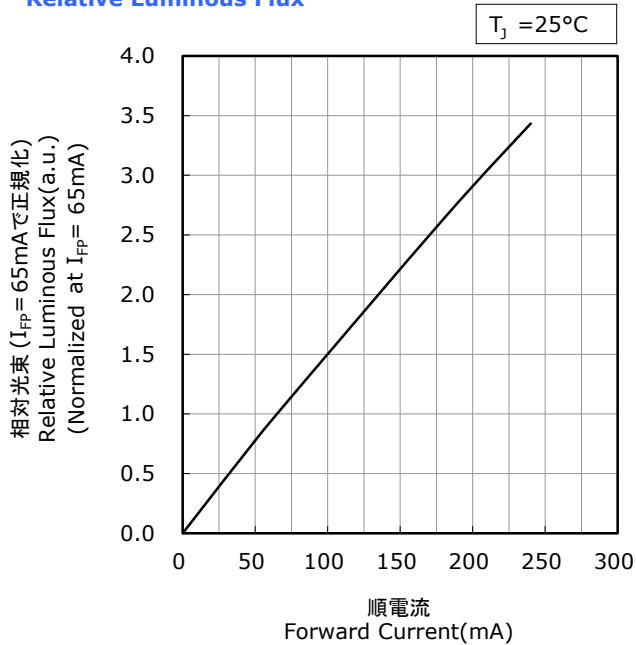
順電圧-順電流特性
Forward Voltage vs
Forward Current



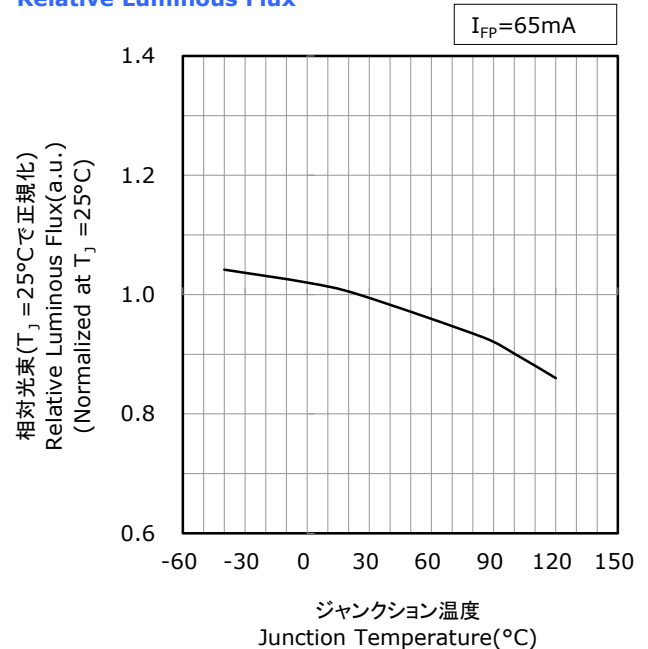
ジャンクション温度-順電圧特性
Junction Temperature vs
Forward Voltage



順電流-相対光束特性
Forward Current vs
Relative Luminous Flux



ジャンクション温度-相対光束特性
Junction Temperature vs
Relative Luminous Flux



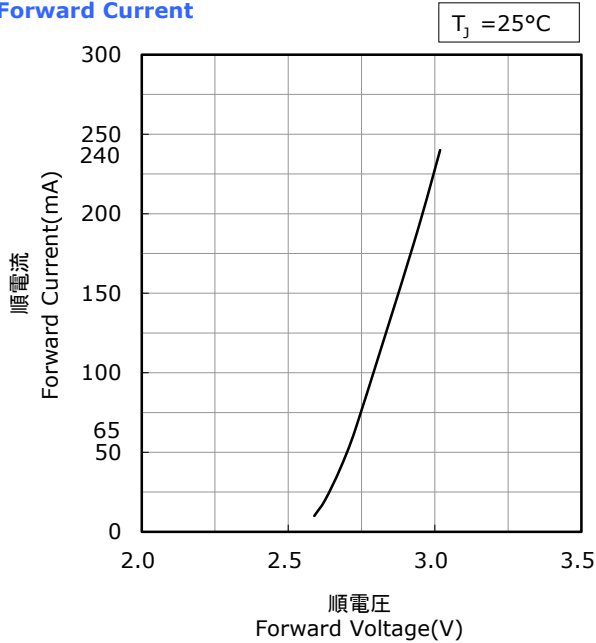
- * 本特性は色温度2700K~4500K、演色性ランクR9050に対応しています。
The graphs above show the characteristics for 2700K~4500K, R9050 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

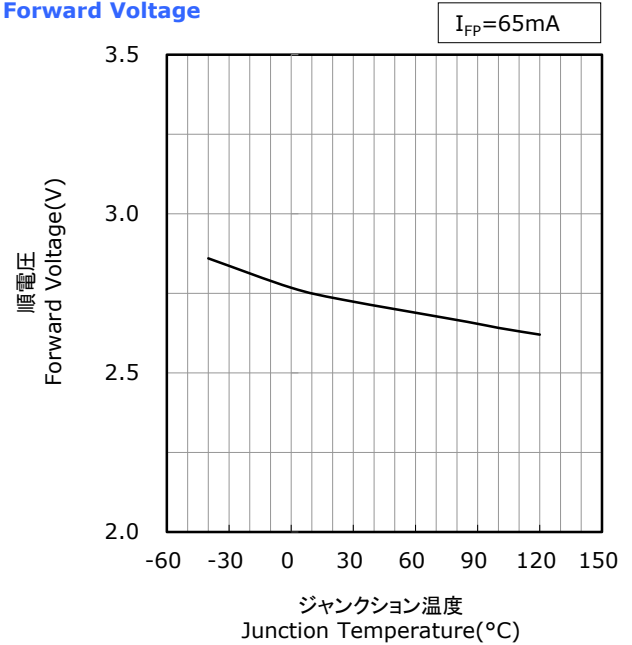
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13992

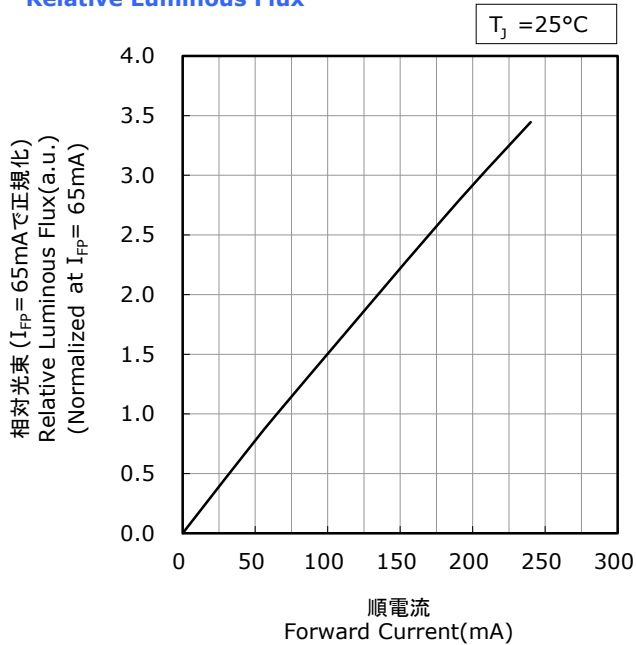
順電圧-順電流特性
Forward Voltage vs
Forward Current



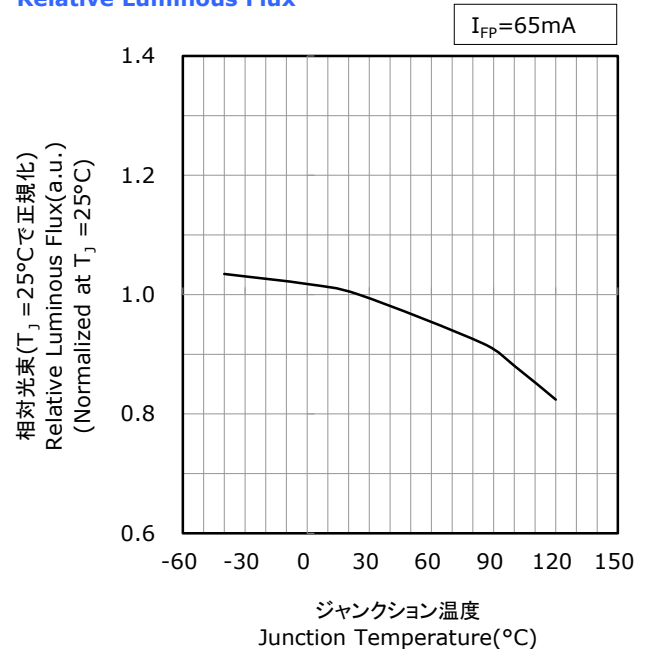
ジャンクション温度-順電圧特性
Junction Temperature vs
Forward Voltage



順電流-相対光束特性
Forward Current vs
Relative Luminous Flux



ジャンクション温度-相対光束特性
Junction Temperature vs
Relative Luminous Flux



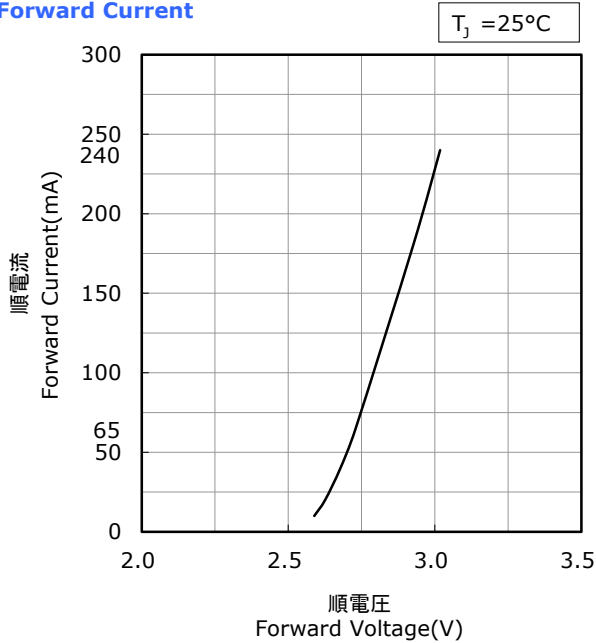
- * 本特性は色温度5000K~6500K、演色性ランクR70に対応しています。
The graphs above show the characteristics for 5000K~6500K, R70 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

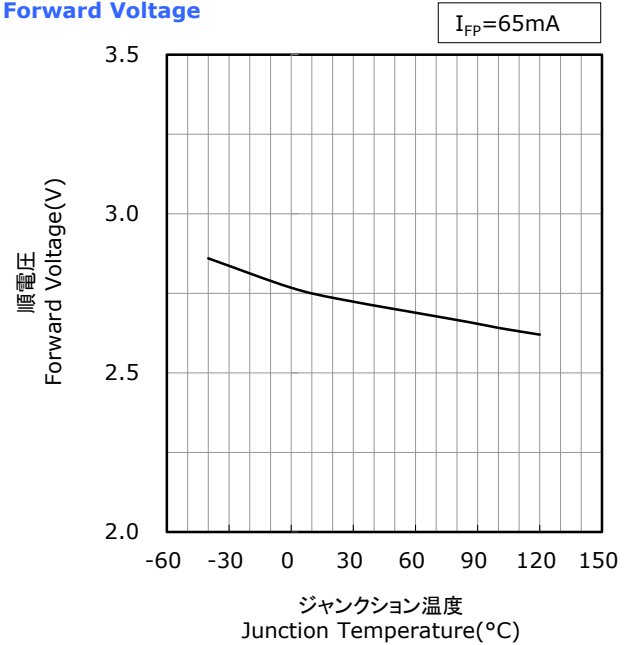
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13993

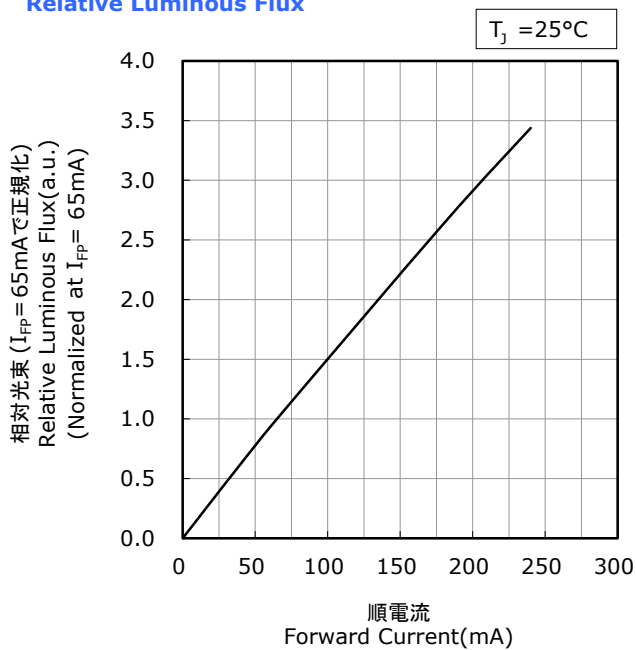
順電圧-順電流特性
Forward Voltage vs
Forward Current



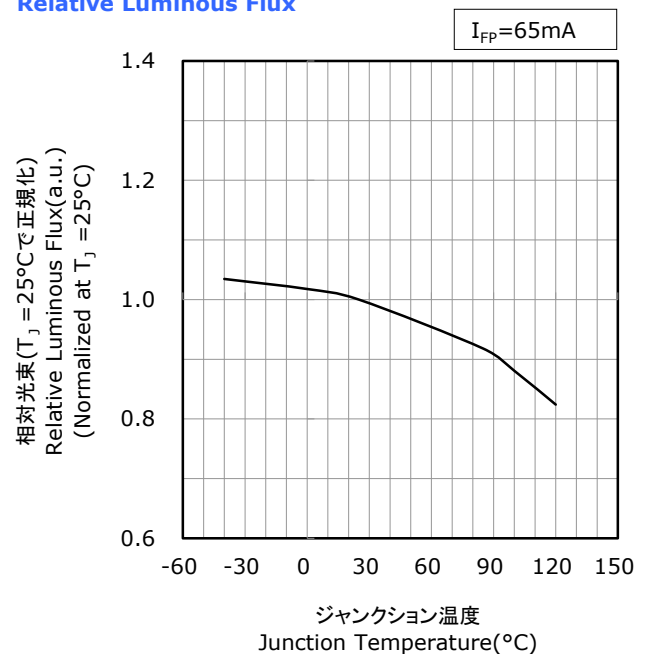
ジャンクション温度-順電圧特性
Junction Temperature vs
Forward Voltage



順電流-相対光束特性
Forward Current vs
Relative Luminous Flux



ジャンクション温度-相対光束特性
Junction Temperature vs
Relative Luminous Flux



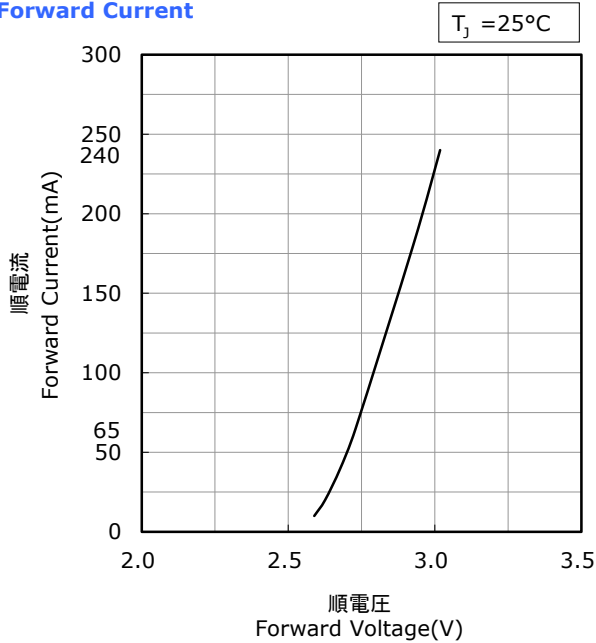
- * 本特性は色温度5000K~6500K、演色性ランクR8000に対応しています。
The graphs above show the characteristics for 5000K~6500K, R8000 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

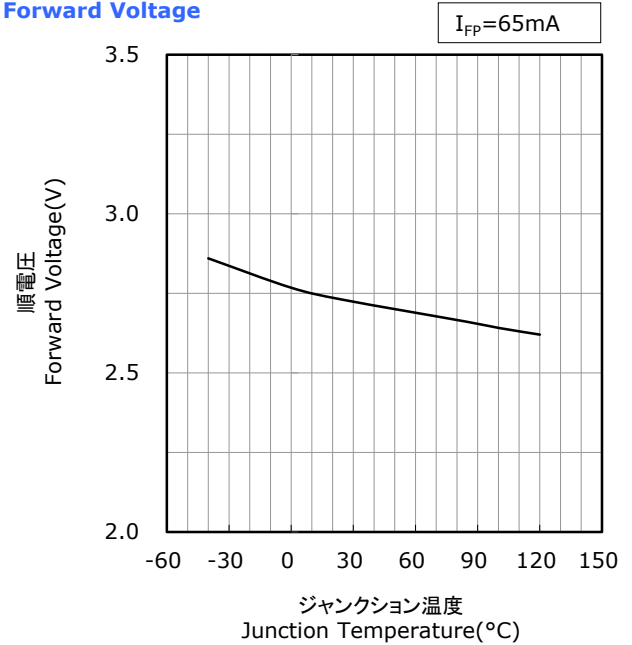
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13994

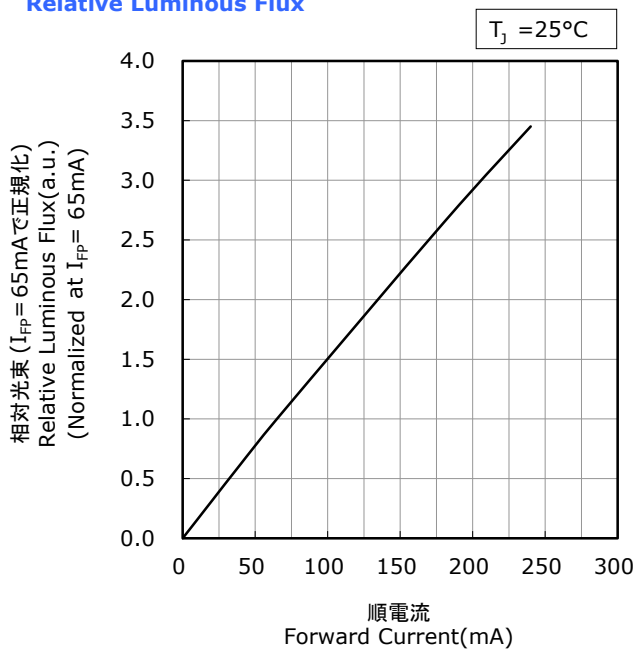
順電圧-順電流特性
Forward Voltage vs
Forward Current



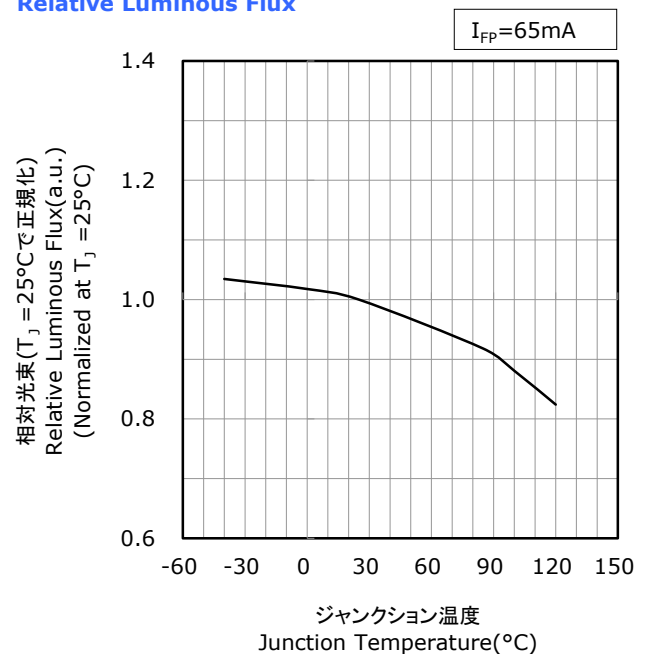
ジャンクション温度-順電圧特性
Junction Temperature vs
Forward Voltage



順電流-相対光束特性
Forward Current vs
Relative Luminous Flux



ジャンクション温度-相対光束特性
Junction Temperature vs
Relative Luminous Flux



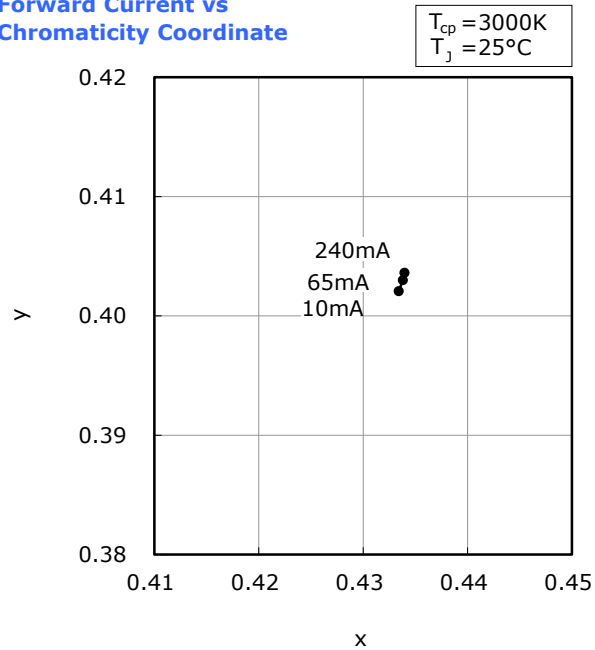
- * 本特性は色温度5000K~6500K、演色性ランクR9050に対応しています。
The graphs above show the characteristics for 5000K~6500K, R9050 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

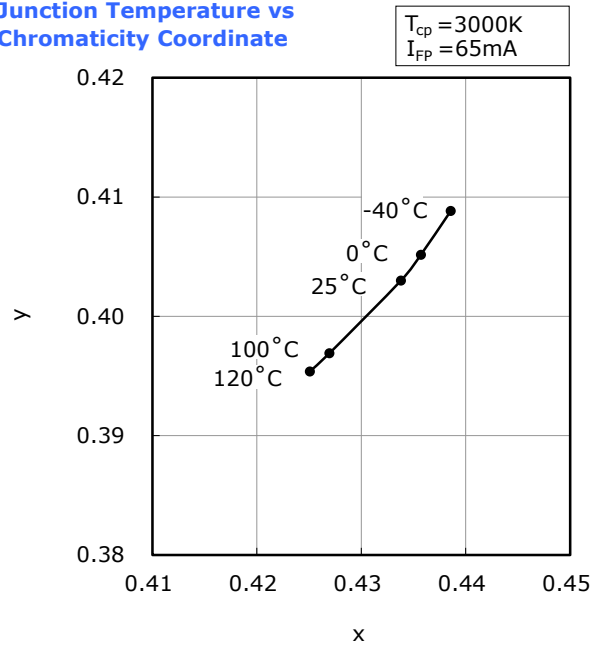
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13995

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate



ジャンクション温度-色度 特性
Junction Temperature vs
Chromaticity Coordinate



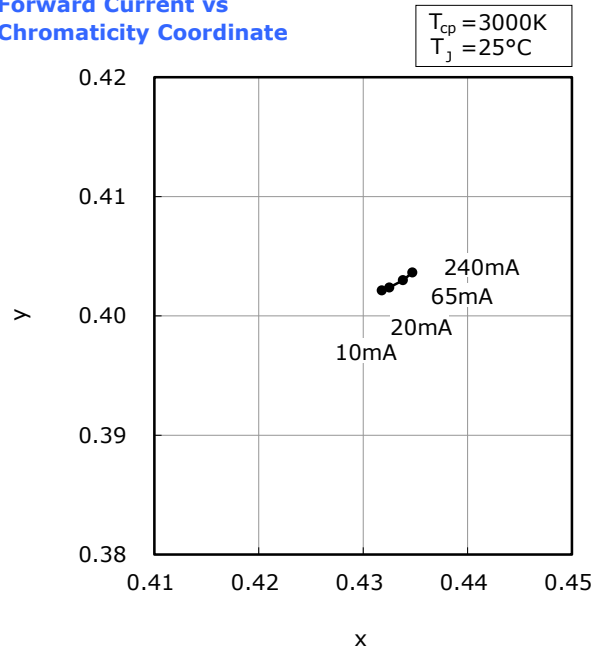
- * 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

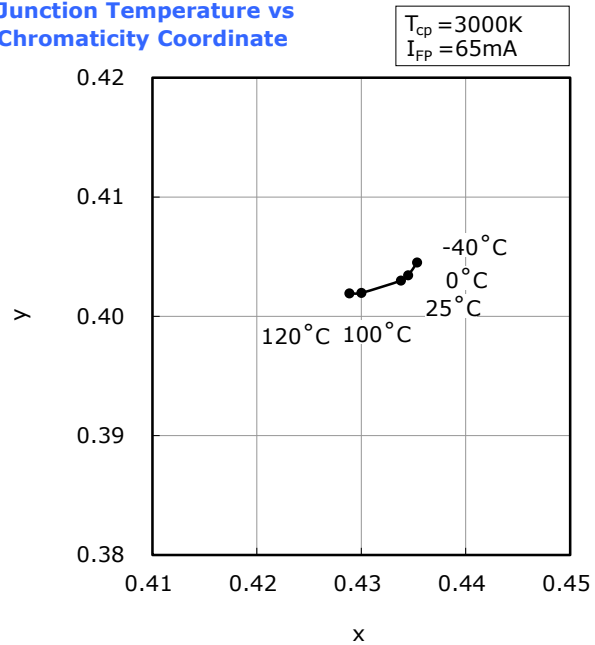
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13996

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate



ジャンクション温度-色度 特性
Junction Temperature vs
Chromaticity Coordinate



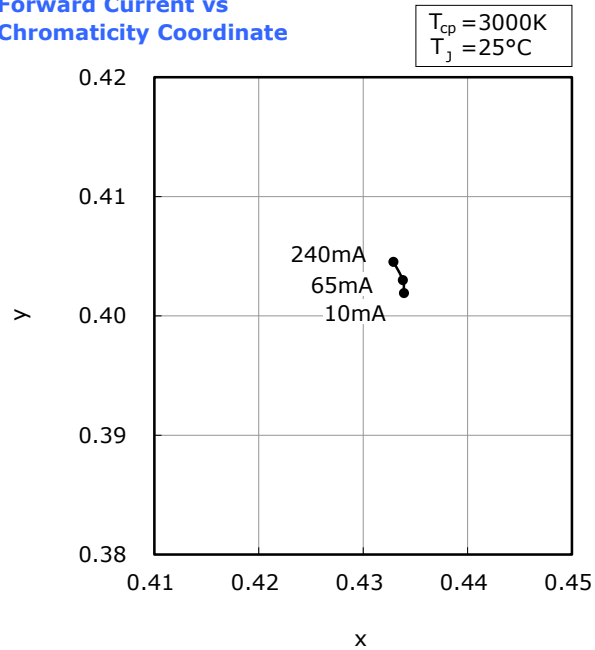
- * 本特性は演色性ランクR8000に対応しています。
The graphs above show the characteristics for R8000 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

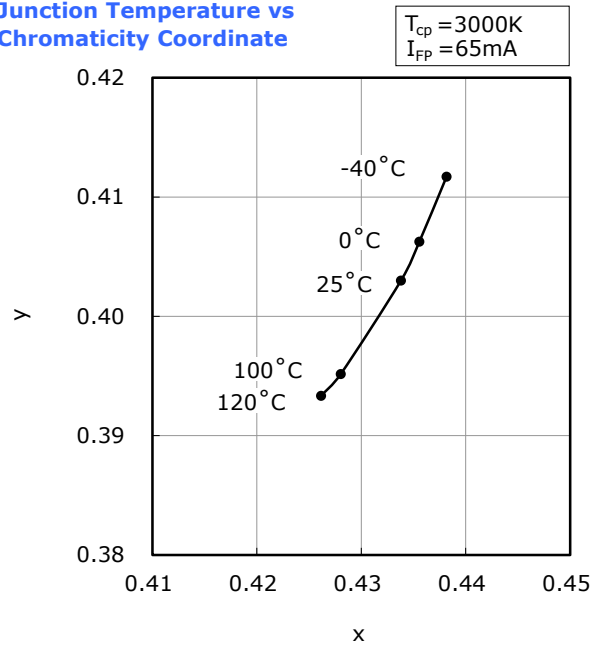
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13997

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate



ジャンクション温度-色度 特性
Junction Temperature vs
Chromaticity Coordinate



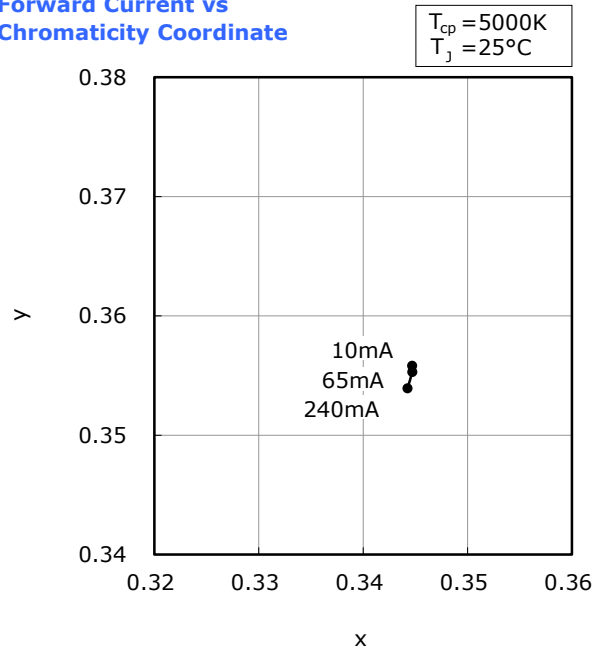
- * 本特性は演色性ランクR9050に対応しています。
The graphs above show the characteristics for R9050 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

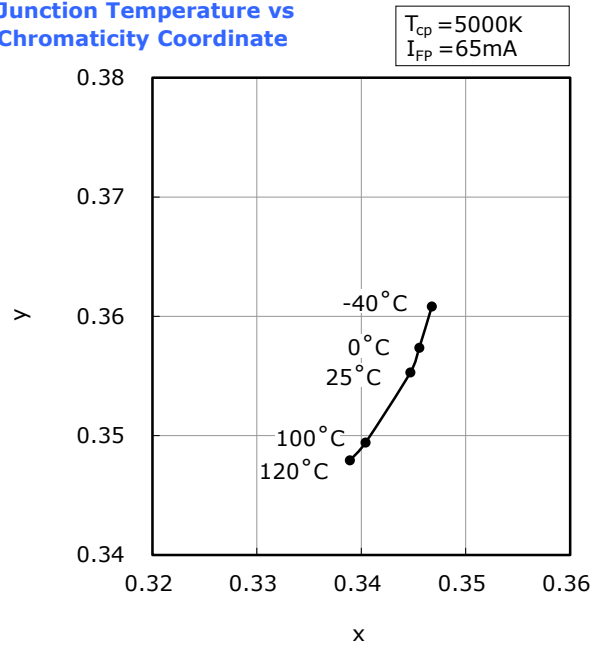
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13998

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate



ジャンクション温度-色度 特性
Junction Temperature vs
Chromaticity Coordinate



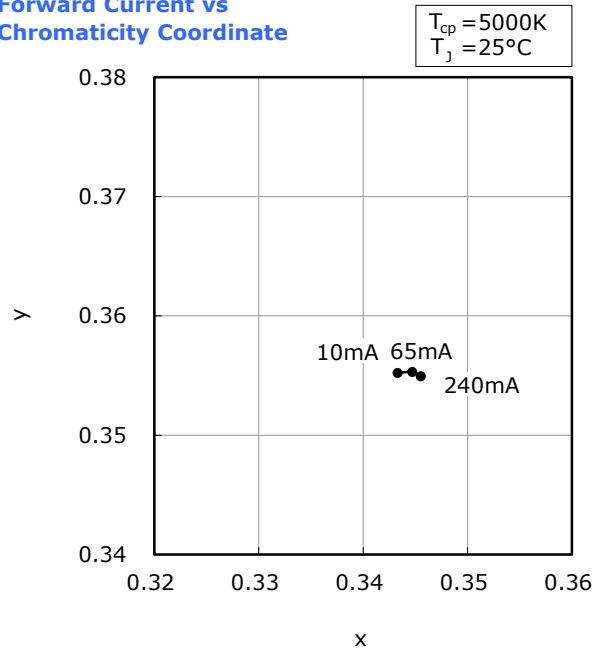
- * 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

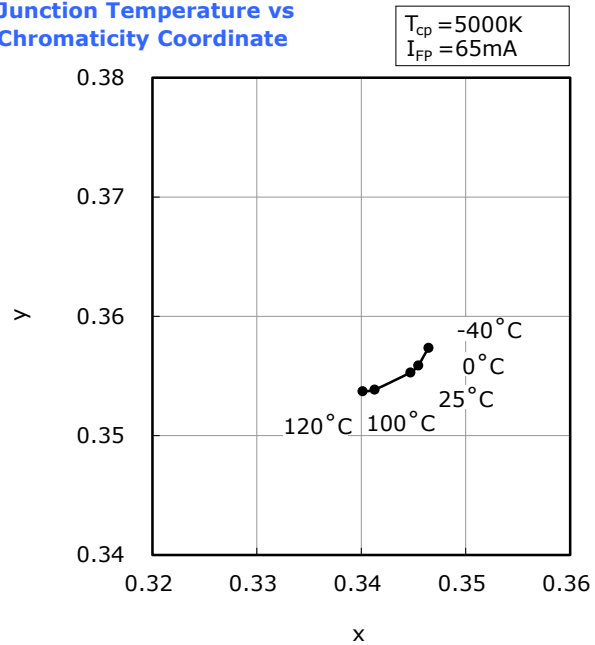
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-13999

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate



ジャンクション温度-色度 特性
Junction Temperature vs
Chromaticity Coordinate



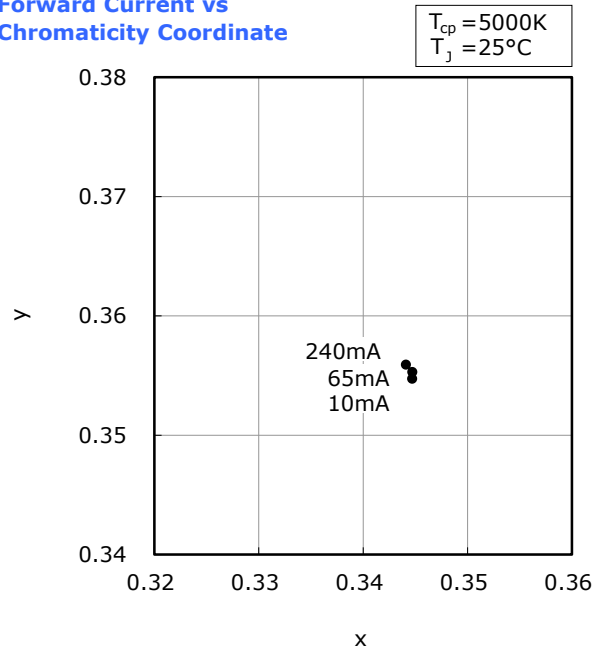
- * 本特性は演色性ランクR8000に対応しています。
The graphs above show the characteristics for R8000 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

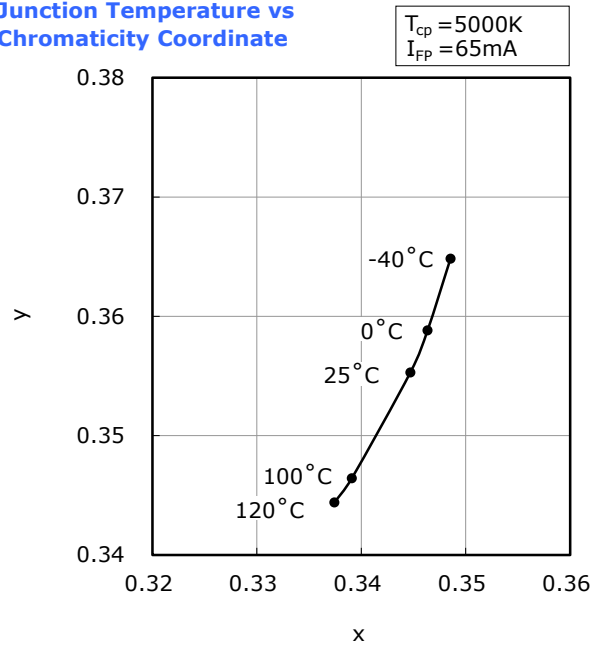
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NF2W757G-V3F1
管理番号 No. STS-DA7-14000

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate



ジャンクション温度-色度 特性
Junction Temperature vs
Chromaticity Coordinate



- * 本特性は演色性ランクR9050に対応しています。
The graphs above show the characteristics for R9050 LEDs of this product.

RELIABILITY

(1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	$T_{\text{slid}}=260^{\circ}\text{C}$, 10sec, 2reflows, Precondition: 30°C , 70%RH, 168hr		#1	0/22
Solderability (Reflow Soldering)	JEITA ED-4701 303 303A	$T_{\text{slid}}=245\pm 5^{\circ}\text{C}$, 5sec, Lead-free Solder(Sn-3.0Ag-0.5Cu)		#2	0/22
Temperature Cycle	JEITA ED-4701 100 105	$-40^{\circ}\text{C}(30\text{min})\sim 25^{\circ}\text{C}(5\text{min})\sim 100^{\circ}\text{C}(30\text{min})\sim 25^{\circ}\text{C}(5\text{min})$	100cycles	#1	0/50
Moisture Resistance (Cyclic)	JEITA ED-4701 200 203	$25^{\circ}\text{C}\sim 65^{\circ}\text{C}\sim -10^{\circ}\text{C}$, 90%RH, 24hr per cycle	10cycles	#1	0/22
High Temperature Storage	JEITA ED-4701 200 201	$T_A=100^{\circ}\text{C}$	1000hours	#1	0/22
Temperature Humidity Storage	JEITA ED-4701 100 103	$T_A=60^{\circ}\text{C}$, RH=90%	1000hours	#1	0/22
Low Temperature Storage	JEITA ED-4701 200 202	$T_A=-40^{\circ}\text{C}$	1000hours	#1	0/22
Room Temperature Operating Life Condition 1		$T_A=25^{\circ}\text{C}$, $I_F=65\text{mA}$ Test board: See NOTES below	1000hours	#1	0/22
Room Temperature Operating Life Condition 2		$T_A=25^{\circ}\text{C}$, $I_F=180\text{mA}$ Test board: See NOTES below	500hours	#1	0/22
High Temperature Operating Life		$T_A=100^{\circ}\text{C}$, $I_F=70\text{mA}$ Test board: See NOTES below	1000hours	#1	0/22
Temperature Humidity Operating Life		60°C , RH=90%, $I_F=65\text{mA}$ Test board: See NOTES below	500hours	#1	0/22
Low Temperature Operating Life		$T_A=-40^{\circ}\text{C}$, $I_F=65\text{mA}$ Test board: See NOTES below	1000hours	#1	0/22
Vibration	JEITA ED-4701 400 403	200m/s^2 , 100~2000~100Hz, 4cycles, 4min, each X, Y, Z	48minutes	#1	0/22
Electrostatic Discharges	JEITA ED-4701 300 304	HBM, 2kV, 1.5k Ω , 100pF, 3pulses, alternately positive or negative		#1	0/22
Board Bending		1bend to a deflection of 2mm for $5\pm 1\text{sec}$		#3	0/22
Soldering Joint Shear Strength	JEITA ED-4702B 002 3	5N, $10\pm 1\text{sec}$		#1	0/22

NOTES:

- 1) Test board: FR4 board thickness=1.6mm, copper layer thickness=0.07mm, $R_{\theta JA}\approx 74^{\circ}\text{C/W}$
The Board Bending is performed using an exclusive test board.
- 2) Measurements are performed after allowing the LEDs to return to room temperature.

(2) Failure Criteria

Criteria #	Items	Conditions	Failure Criteria
#1	Forward Voltage(V_F)	$I_F=65\text{mA}$	$> \text{U.S.L.} \times 1.1$
	Luminous Flux(Φ_V)	$I_F=65\text{mA}$	$< \text{L.S.L.} \times 0.7$
#2	Solderability	-	Less than 95% solder coverage
#3	Appearance	-	The light emission is abnormal

U.S.L. : Upper Specification Limit L.S.L. : Lower Specification Limit

CAUTIONS

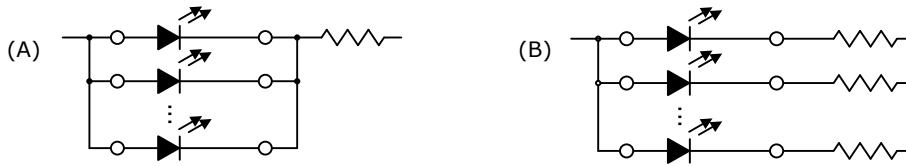
(1) Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	$\leq 30^{\circ}\text{C}$	$\leq 90\%\text{RH}$	Within 1 Year from Delivery Date
	After Opening Aluminum Bag	$\leq 30^{\circ}\text{C}$	$\leq 70\%\text{RH}$	$\leq 168\text{hours}$
Baking		$65 \pm 5^{\circ}\text{C}$	-	$\geq 24\text{hours}$

- The storage/packaging requirements for this LED are comparable to JEDEC Moisture Sensitivity Level (MSL) 3 or equivalent. Nichia used IPC/JEDEC STD-020 as a reference to rate the MSL of this LED.
- This LED uses a package that could absorb moisture; if the package absorbs moisture and is exposed to heat during soldering, it may cause the moisture to vaporize and the package to expand and the resulting pressure may cause internal delamination. This may cause the optical characteristics to degrade. To minimize moisture absorption in storage/transit, moisture-proof aluminum bags are used for the LEDs with a silica gel packet to absorb any air moisture in the bag. The silica gel beads turn blue to red as they absorb moisture.
- Once the moisture-proof aluminum bag is open, ensure that the LED is soldered to a PCB within the range of the conditions above. To store any remaining unused LEDs, use a hermetically sealed container with silica gel desiccants. Nichia recommends placing them back to the original moisture-proof bag and reseal it.
- If the "After Opening" storage time has been exceeded or any pink silica gel beads are found, ensure that the LED are baked before use. Baking should only be done once.
- This LED has silver-plated parts both inside and outside of the package. If the LEDs are exposed to a corrosive environment, it may cause the plated surface to tarnish causing issues (i.e. solderability, optical characteristics). Ensure that when storing LEDs, a hermetically sealed container is used. Nichia recommends placing them back to the original moisture-proof bag and reseal it.
- Ensure that when designing, there are no issues with the parts/materials used with the LEDs. The following must be taken into consideration:
 - After soldering LEDs to a PCB and/or installing them in a system, it is possible that the LEDs will be exposed to corrosive gases released from parts/materials used with the LEDs in the same assembly/system (e.g. rubber materials, cardboard boxes) and/or gases entering from the outside; the plated surface may tarnish depending on the gas component.
 - Small amounts of corrosive gas may be found in the air.
 - Resin materials may contain substances (e.g. halogens) that affect the plated surfaces of the LEDs.
- To prevent substances/gases from affecting the plated surface, ensure that the parts/materials used with the LEDs in the same assembly/system do not contain sulfur (e.g. gasket/seal, adhesive, etc.). If the plating becomes extremely corroded or contaminated, it may cause issues (e.g. electrical connection failures). If a gasket/seal is used, silicone rubber gaskets/seals are recommended; ensure that this use of silicone does not result in issues (e.g. electrical connection failures) caused by low molecular weight volatile siloxane.
- To avoid condensation, the LEDs must not be stored in areas where temperature and humidity fluctuate greatly.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment over a long period of time where the temperature is higher than normal room temperature.

(2) Directions for Use

- The circuit must be designed to ensure that the Absolute Maximum Ratings are not exceeded for each LED. The LEDs should be operated at a constant current per LED. In the case of operating at a constant voltage, Circuit B is recommended. If Circuit A is used, it may cause the currents flowing through the LEDs to vary due to the variation in the forward voltage characteristics of the LEDs on the circuit.



- This LED is designed to be operated at a forward current. Ensure that no voltage is applied to the LED in the forward/reverse direction while the LED is off. If the LEDs are used in an environment where reverse voltages are applied to the LED continuously, it may cause electrochemical migration to occur causing the LED to be damaged. When not in use for a long period of time, the system's power should be turned off to ensure that there are no issues/damage.
- To stabilize the LED characteristics while in use, Nichia recommends that the LEDs are operated at currents $\geq 10\%$ of the sorting current.
- Ensure that transient excessive voltages (e.g. lighting surge) are not applied to the LEDs.
- If the LEDs are used for outdoor applications, ensure that necessary measures are taken (e.g. protecting the LEDs from water/salt damage and high humidity).

(3) Handling Precautions

- Do not handle the LEDs with bare hands:
 - this may contaminate the LED surface and have an effect on the optical characteristics,
 - this may cause the LED to deform and/or the wire to break causing a catastrophic failure (i.e. the LED not to illuminate).
- Ensure that when handling the LEDs with tweezers, excessive force is not applied to the LED. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the wire to break causing a catastrophic failure (i.e. the LED not to illuminate).
- Dropping may cause damage to the LED (e.g. deformation).
- Do not stack assembled PCBs together. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the wire to break causing a catastrophic failure (i.e. the LED not to illuminate).
- CRI Rank R9050 LEDs in this specification use materials that contain halogen-based compounds; the halogen element found in these materials will not affect the LEDs when the LEDs are used under the conditions detailed in this specification. The other CRI ranks in this specification do not use these materials.
- Due to the variation in the amount of the reflective material (white resin) that is coating the protection device, the area around the protection device may appear to be a black spot; this will not affect the characteristics of the LED. Do not use the location of the protection device to determine the polarity of the LED; use the cathode mark.

(4) Design Consideration

- If the LEDs are soldered to a PCB and the PCB assembly is bent (e.g. PCB depaneling process), it may cause the LED package to break. The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB assembly is bent/warped.
- The amount of mechanical stress exerted on the LED from depaneling may vary depending on the LED position/orientation on the PCB assembly (e.g. especially in areas near V-groove scores). The PCB layout should be designed to minimize the mechanical stress on the LEDs when the PCB is separated into individual PCB assemblies.
- To separate a PCB populated with the LEDs, use a specially designed tool. Do not break the PCB by hand.
- Volatile organic compounds that have been released from materials present around the LEDs (e.g. housing, gasket/seal, adhesive, secondary lens, lens cover, etc.) may penetrate the LED lens and/or encapsulating resin. If the LEDs are being used in a hermetically sealed environment, these volatile compounds can discolor after being exposed to heat and/or photon energy and it may greatly reduce the LED light output and/or color shift. In this case, ventilating the environment may improve the reduction in light output and/or color shift. Perform a light-up test of the chosen application for optical evaluation to ensure that there are no issues, especially if the LEDs are planned to be used in a hermetically sealed environment.

(5) Electrostatic Discharge (ESD)

- This LED is sensitive to transient excessive voltages (e.g. ESD, lightning surge). If this excessive voltage occurs in the circuit, it may cause the LED to be damaged causing issues (e.g. the LED to become dimmer or not to illuminate [i.e. catastrophic failure]). Ensure that when handling the LEDs, necessary measures are taken to protect them from an ESD discharge. The following examples are recommended measures to eliminate the charge:
 - Grounded wrist strap, ESD footwear, clothes, and floors
 - Grounded workstation equipment and tools
 - ESD table/shelf mat made of conductive materials
- Ensure that all necessary measures are taken to prevent the LEDs from being exposed to transient excessive voltages (e.g. ESD, lightning surge):
 - tools (e.g. soldering irons), jigs, and machines that are used are properly grounded
 - appropriate ESD materials/equipment are used in the work area
 - the system/assembly is designed to provide ESD protection for the LEDs.
- If the tool/equipment used is an insulator (e.g. glass cover, plastic, etc.), ensure that necessary measures have been taken to protect the LED from transient excessive voltages (e.g. ESD). The following examples are recommended measures to eliminate the charge:
 - Dissipating static charge with conductive materials
 - Preventing charge generation with moisture
 - Neutralizing the charge with ionizers
- To detect if an LED was damaged by transient excess voltages (i.e. an ESD event during the system's assembly process), perform a characteristics inspection (e.g. forward voltage measurement) at low current ($\leq 2\text{mA}$).
- Failure Criteria: $V_F < 2.0\text{V}$ at $I_F = 1.0\text{mA}$
 If the LED is damaged by transient excess voltages (e.g. ESD), it will cause the Forward Voltage (V_F) to decrease.

(6) Thermal Management

- The Absolute Maximum Junction Temperature (T_J) must not be exceeded under any circumstances. The increase in the temperature of an LED while in operation may vary depending on the PCB thermal resistance and the density of LEDs on the PCB assembly. Ensure that when using the LEDs for the chosen application, heat is not concentrated in an area and properly managed in the system/assembly.
- The operating current should be determined by considering the temperature conditions surrounding the LED (i.e. T_A). Ensure that when operating the LED, proper measures are taken to dissipate the heat.
- The following equations can be used to calculate the LED temperature (i.e. T_J) once the saturation temperature at the junction has been reached.

$$1) T_J = T_A + R_{\theta JA} \cdot W \quad 2) T_J = T_S + R_{\theta JS} \cdot W$$

* T_J = LED Junction Temperature: $^{\circ}\text{C}$

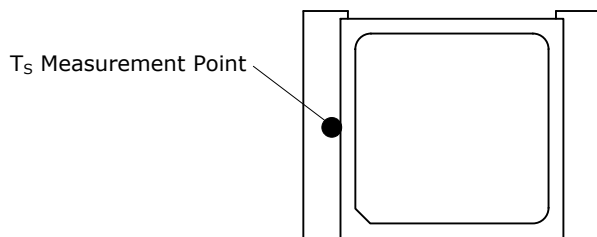
T_A = Ambient Temperature: $^{\circ}\text{C}$

T_S = Soldering Temperature (Cathode Side): $^{\circ}\text{C}$

$R_{\theta JA}$ = Thermal Resistance from Junction to Ambient: $^{\circ}\text{C/W}$

$R_{\theta JS}$ = Thermal Resistance from Junction to T_S Measurement Point: $^{\circ}\text{C/W}$

W = Input Power ($I_F \times V_F$): W



(7) Cleaning

- Do not wipe/clean the LEDs with a damp cloth soaked in water or solvents (e.g. benzine, thinner, etc.).
- If required, use isopropyl alcohol (IPA). If water or other solvent is used, it may cause issues. Before using the solvent, ensure that sufficient verification is performed to ensure that the solvent does not adversely affect the LEDs. In addition, the use of CFCs such as Freon is heavily regulated.
- When a foreign substance (e.g. dust, debris, loose materials, etc.) adheres to the LEDs, wipe it off with a damp well-squeezed cloth that was soaked only in isopropyl alcohol (IPA).
- Do not wipe the emitting surface. Otherwise, it may result in excessive pressure to the emitting surface causing issues (e.g. wire to deform, the encapsulating resin to become damaged, the color to change, etc.). If wiping the emitting surface is necessary, ensure that sufficient preliminary verification is performed to ensure that there are no issues; wipe the emitting surface at the customer's risk.
- Do not clean the LEDs with an ultrasonic cleaner. If cleaning must be done, ensure that sufficient verification is performed by using a finished assembly with LEDs to determine cleaning conditions (e.g. ultrasonic power, LED position on the PCB assembly) that do not cause an issue.

(8) Eye Safety

- There may be two important international specifications that should be noted for safe use of the LEDs: IEC 62471:2006 Photobiological safety of lamps and lamp systems and IEC 60825-1:2001 (i.e. Edition 1.2) Safety of Laser Products - Part 1: Equipment Classification and Requirements. Ensure that when using the LEDs, there are no issues with the following points:
 - LEDs have been removed from the scope of IEC 60825-1 since IEC 60825-1:2007 (i.e. Edition 2.0) was published. However, depending on the country/region, there are cases where the requirements of the IEC 60825-1:2001 specifications or equivalent must be adhered to.
 - LEDs have been included in the scope of IEC 62471:2006 since the release of the specification in 2006.
 - Most Nichia LEDs will be classified as the Exempt Group or Risk Group 1 according to IEC 62471:2006. However, in the case of high-power LEDs containing blue wavelengths in the emission spectrum, there are LEDs that will be classified as Risk Group 2 depending on the characteristics (e.g. radiation flux, emission spectrum, directivity, etc.)
 - If the LED is used in a manner that produces an increased output or with an optic to collimate the light from the LED, it may cause damage to the human eye.
- If an LED is operated in a manner that emits a flashing light, it may cause health issues (e.g. visual stimuli causing eye discomfort). The system should be designed to ensure that there are no harmful effects on the human body.

(9) Miscellaneous

- Nichia warrants that the discrete LEDs will meet the requirements/criteria as detailed in the Reliability section within this specification. If the LEDs are used under conditions/environments deviating from or inconsistent with those described in this specification, the resulting damage and/or injuries will not be covered by this warranty.
- Nichia warrants that the discrete LEDs manufactured and/or supplied by Nichia will meet the requirements/criteria as detailed in the Reliability section within this specification; it is the customer's responsibility to perform sufficient verification prior to use to ensure that the lifetime and other quality characteristics required for the intended use are met.
- The applicable warranty period is one year from the date that the LED is delivered. In the case of any incident that appears to be in breach of this warranty, the local Nichia sales representative should be notified to discuss instructions on how to proceed while ensuring that the LED in question is not disassembled or removed from the PCB if it has been attached to the PCB. If a breach of this warranty is proved, Nichia will provide the replacement for the non-conforming LED or an equivalent item at Nichia's discretion. FOREGOING ARE THE EXCLUSIVE REMEDIES AVAILABLE TO THE CUSTOMER IN RESPECT OF THE BREACH OF THE WARRANTY CONTAINED HEREIN, AND IN NO EVENT SHALL NICHIA BE RESPONSIBLE FOR ANY INDIRECT, INCIDENTAL OR CONSEQUENTIAL LOSSES AND/OR EXPENSES (INCLUDING LOSS OF PROFIT) THAT MAY BE SUFFERED BY THE CUSTOMER ARISING OUT OF A BREACH OF THE WARRANTY.
- NICHIA DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.
- This LED is intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices); it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, automobiles, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LED is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health. This LED does not comply with ISO/TS 16949 and is not intended for automotive applications.
- The customer will not reverse engineer, disassemble or otherwise attempt to extract knowledge/design information from the LED.
- All copyrights and other intellectual property rights in this specification in any form are reserved by Nichia or the right holders who have granted Nichia permission to use the content. Without prior written permission from Nichia, no part of this specification may be reproduced in any form or by any means.
- Both the customer and Nichia will agree on the official specifications for the supplied LEDs before any programs are officially launched. Without this agreement in writing (i.e. Customer Specific Specification), changes to the content of this specification may occur without notice (e.g. changes to the foregoing specifications and appearance, discontinuation of the LEDs, etc.).